Features

- Core
 - ARM® Cortex®-M3 revision 2.0 running at up to 96 MHz
 - Memory Protection Unit (MPU)
 - Thumb[®]-2 instruction set
- Memories
 - From 64 to 256 Kbytes embedded Flash, 128-bit wide access, memory accelerator, dual bank
 - From 16 to 48 Kbytes embedded SRAM with dual banks
 - 16 Kbytes ROM with embedded bootloader routines (UART, USB) and IAP routines
 - Static Memory Controller (SMC): SRAM, NOR, NAND support. NAND Flash controller with 4 Kbytes RAM buffer and ECC
- System
 - Embedded voltage regulator for single supply operation
 - POR, BOD and Watchdog for safe reset
 - Quartz or resonator oscillators: 3 to 20 MHz main and optional low power 32.768 kHz for RTC or device clock.
 - High precision 8/12 MHz factory trimmed internal RC oscillator with 4 MHz Default Frequency for fast device startup
 - Slow Clock Internal RC oscillator as permanent clock for device clock in low power mode
 - One PLL for device clock and one dedicated PLL for USB 2.0 High Speed Device
 - Up to 17 peripheral DMA (PDC) channels and 4-channel central DMA
- Low Power Modes
 - Sleep and Backup modes, down to 2.5 µA in Backup mode
 - Backup domain: VDDBU pin, RTC, 32 backup registers
 - Ultra low power RTC: 0.6 μA
- Peripherals
 - USB 2.0 Device: 480 Mbps, 4-kbyte FIFO, up to 7 bidirectional Endpoints, dedicated DMA
 - Up to 4 USARTs (ISO7816, IrDA[®], Flow Control, SPI, Manchester support) and one UART
 - Up to 2 TWI (I2C compatible), 1 SPI, 1 SSC (I2S), 1 HSMCI (SDIO/SD/MMC)
 - 3-Channel 16-bit Timer/Counter (TC) for capture, compare and PWM
 - 4-channel 16-bit PWM (PWMC)
 - 32-bit Real Time Timer (RTT) and RTC with calendar and alarm features
 - 8-channel 12-bit 1MSPS ADC with differential input mode and programmable gain stage, 8-channel 10-bit ADC
- I/O
 - Up to 96 I/O lines with external interrupt capability (edge or level sensitivity), debouncing, glitch filtering and on-die Series Resistor Termination
 Three 32-bit Parallel Input/Outputs (PIO)
- Packages
 - 100-lead LQFP, 14 x 14 mm, pitch 0.5 mm
 - 100-ball LFBGA, 9 x 9 mm, pitch 0.8 mm
 - 144-lead LQFP, 20 x 20 mm, pitch 0.5 mm
 - 144-ball LFBGA, 10 x 10 mm, pitch 0.8 mm



AT91ARM Cortex M3-based Microcontrollers

ATSAM3U Series

Preliminary

Summary

NOTE: This is a summary document. The complete document is available on the Atmel website at www.atmel.com.

6430CS-ATARM-09-Apr-10





1. SAM3U Description

Atmel's SAM3U series is a member of a family of Flash microcontrollers based on the high performance 32-bit ARM Cortex-M3 RISC processor. It operates at a maximum speed of 96 MHz and features up to 256 Kbytes of Flash and up to 52 Kbytes of SRAM. The peripheral set includes a High Speed USB Device port with embedded transceiver, a High Speed MCI for SDIO/SD/MMC, an External Bus Interface with NAND Flash controller, up to 4xUSARTs (SAM3U1C/2C/4C have 3), up to 2xTWIs (SAM3U1C/2C/4C have 1), up to 5xSPIs SAM3U1C/2C/4C have 4), as well as 4xPWM timers, 3xgeneral purpose 16-bit timers, an RTC, a 12-bit ADC and a 10-bit ADC.

The SAM3U architecture is specifically designed to sustain high speed data transfers. It includes a multi-layer bus matrix as well as multiple SRAM banks, PDC and DMA channels that enable it to run tasks in parallel and maximize data throughput.

It can operate from 1.62V to 3.6V and comes in 100-pin and 144-pin LQFP and BGA packages.

The SAM3U device is particularly well suited for USB applications: data loggers, PC peripherals and any high speed bridge (USB to SDIO, USB to SPI, USB to External Bus Interface).

1.1 Configuration Summary

The SAM3U series differ in memory sizes, package and features list. Table 1-1 summarizes the configurations of the six devices.

Device	Flash	Flash Organization	SRAM	Number of PIOs	Number of USARTs	Number of TWI	FWUP, SHDN pins	External Bus Interface	HSMCI data size	Package	ADC
SAM3U4E	2x128 Kbytes	dual plane	52 Kbytes	96	4	2	Yes	8 or 16 bits, 4 chip selects, 24-bit address	8 bits	LQFP144 BGA144	2 (8+ 8 channels)
SAM3U2E	128 Kbytes	single plane	36 Kbytes	96	4	2	Yes	8 or 16 bits, 4 chip selects 24-bit address	8 bits	LQFP144 BGA144	2 (8+ 8 channels)
SAM3U1E	64 Kbytes	single plane	20 Kbytes	96	4	2	Yes	8 or 16 bits, 4 chip selects, 24-bit address	8 bits	LQFP144 BGA144	2 (8+ 8 channels)
SAM3U4C	2 x 128 Kbytes	dual plane	52 Kbytes	57	3	1	FWUP	8 bits, 2 chip selects, 8-bit address	4 bits	LQFP100 BGA100	2 (4+ 4 channels)
SAM3U2C	128 Kbytes	single plane	36 Kbytes	57	3	1	FWUP	8 bits, 2 chip selects, 8- bit address	4 bits	LQFP100 BGA100	2 (4+ 4 channels)
SAM3U1C	64 Kbytes	single plane	20 Kbytes	57	3	1	FWUP	8 bits 2 chip selects, 8-bit address	4 bits	LQFP100 BGA100	2 (4+ 4 channels)

 Table 1-1.
 Configuration Summary

Note: 1. The SRAM size takes into account the 4-Kbyte RAM buffer of the NAND Flash Controller (NFC) which can be used by the core if not used by the NFC.

2. SAM3U Block Diagram

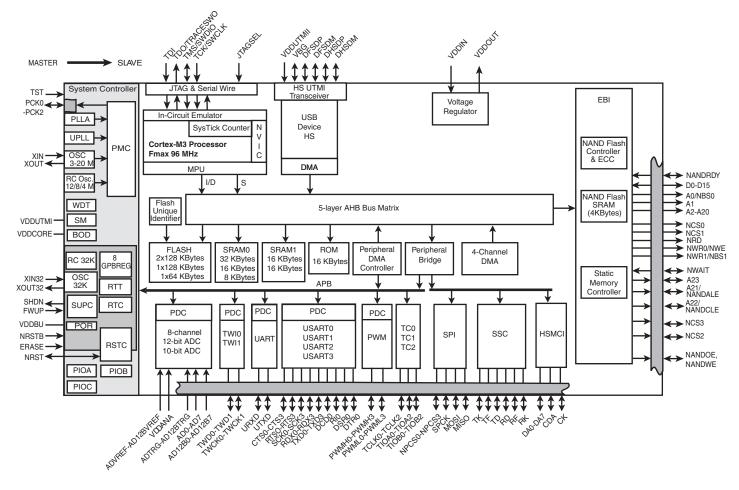


Figure 2-1. 144-pin SAM3U4/2/1E Block Diagram





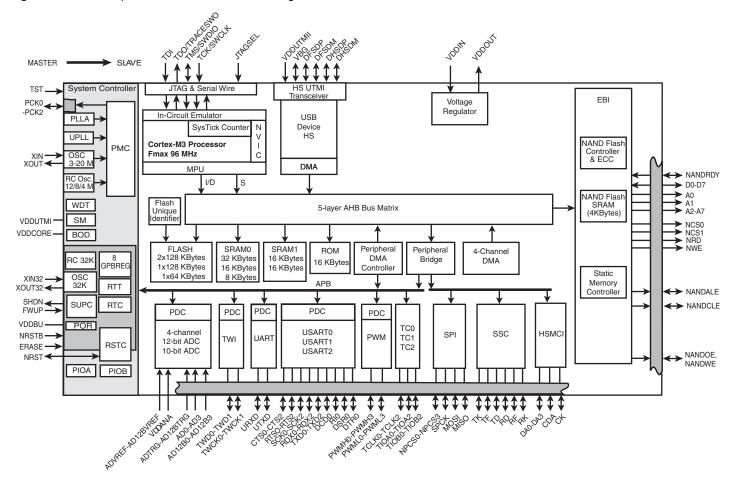


Figure 2-2. 100-pin SAM3U4/2/1C Block Diagram

3. Signal Description

Table 3-1 gives details on the signal names classified by peripheral.

Table 3-1.Signal Description List

Signal Name	Function	Туре	Active Level	Voltage Reference	Comments
	Power S	upplies			
VDDIO	Peripherals I/O Lines Power Supply	Power			1.62V to 3.6V
VDDIN	Voltage Regulator Input	Power			1.8V to 3.6V
VDDOUT	Voltage Regulator Output	Power			1.8V
VDDUTMII	USB UTMI+ Interface Power Supply	Power			3.0V to 3.6V
GNDUTMII	USB UTMI+ Interface Ground	Ground			
VDDBU	Backup I/O Lines Power Supply	Power			1.62V to 3.6V
GNDBU	Backup Ground	Ground			
VDDPLL	PLL A, UPLL and OSC 3-20 MHz Power Supply	Power			1.62 V to 1.95V
GNDPLL	PLL A, UPLL and OSC 3-20 MHz Ground	Ground			
VDDANA	ADC Analog Power Supply	Power			2.0V to 3.6V
GNDANA	ADC Analog Ground	Ground			
VDDCORE	Core, Memories and Peripherals Chip Power Supply	Power			1.62V to 1.95V
GND	Ground	Ground			
	Clocks, Oscilla	tors and PLL	S	_!	
XIN	Main Oscillator Input	Input		VDDPLL	
XOUT	Main Oscillator Output	Output			
XIN32	Slow Clock Oscillator Input	Input		VDDBU	
XOUT32	Slow Clock Oscillator Output	Output			
VBG	Bias Voltage Reference	Analog			
PCK0 - PCK2	Programmable Clock Output	Output		VDDIO	
	Shutdown, W	akeup Logic			
SHDN	Shut-Down Control	Output		VDDBU	push/pull 0: The device is in backup mode 1: The device is running (not in backup mode)
FWUP	Force Wake-Up Input	Input	Low		Needs external pull-up
	Serial Wire/JTAG De	ebug Port (SV	/J-DP)	·	
TCK/SWCLK	Test Clock/Serial Wire Clock	Input			No pull-up resistor
TDI	Test Data In	Input		VDDIO	No pull-up resistor
TDO/TRACESWO	Test Data Out/Trace Asynchronous Data Out	Output		VIUUV	
TMS/SWDIO	Test Mode Select/Serial Wire Input/Output	Input			No pull-up resistor
JTAGSEL	JTAG Selection	Input	High	VDDBU	Internal permanent pull-down





Table 3-1. Signal Description List (Continued)

Signal Name	Function	Туре	Active Level	Voltage Reference	Comments
	Flash	Memory			
ERASE	Flash and NVM Configuration Bits Erase Command	Input	High	VDDBU	Internal permanent 15K pulldown
	Res	et/Test			
NRST	Microcontroller Reset	I/O	Low	VDDIO	Internal permanent pullup
NRSTB	Asynchronous Microcontroller Reset	Input	Low	- VDDBU	Internal permanent pullup
TST	Test Select	Input			Internal permanent pulldown
	Universal Asynchronous	Receiver Trans	sceiver - UAF	RT	
URXD	UART Receive Data	Input			
UTXD	UART Transmit Data	Output			
	PIO Controller -	PIOA - PIOB -	PIOC		
PA0 - PA31	Parallel IO Controller A	I/O			•Schmitt Trigger ⁽¹⁾ Reset State: •PIO Input •Internal pullup enabled
PB0 - PB31	Parallel IO Controller B	I/O		VDDIO	 Schmitt Trigger ⁽²⁾ Reset State: PIO Input Internal pullup enabled
PC0 - PC31	Parallel IO Controller C	I/O		_	 Schmitt Trigger⁽³⁾ Reset State: PIO Input Internal pullup enabled
	External I	Bus Interface	L.	1	L.
D0 - D15	Data Bus	I/O			
A0 - A23	Address Bus	Output			
NWAIT	External Wait Signal	Input	Low		
	Static Memory	Controller - S	мс	1	L.
NCS0 - NCS3	Chip Select Lines	Output	Low		
NWR0 - NWR1	Write Signal	Output	Low		
NRD	Read Signal	Output	Low		
NWE	Write Enable	Output	Low		
NBS0 - NBS1	Byte Mask Signal	Output	Low		
	NAND Flash	Controller - NF	C	•	
NANDOE	NAND Flash Output Enable	Output	Low		
NANDWE	NAND Flash Write Enable	Output	Low		
NANDRDY	NAND Ready	Input			

SAM3U Series

Table 3-1. Signal Description List (Continued)

Signal Name	Function	Туре	Active Level	Voltage Reference	Comments
	High Speed Multimedia	a Card Interfa	ce - HSMCI		
СК	Multimedia Card Clock	I/O			
CDA	Multimedia Card Slot A Command	I/O			
DA0 - DA7	Multimedia Card Slot A Data	I/O			
	Universal Synchronous Asynchror	nous Receiver	r Transmitter	- USARTx	
SCKx	USARTx Serial Clock	I/O			
TXDx	USARTx Transmit Data	I/O			
RXDx	USARTx Receive Data	Input			
RTSx	USARTx Request To Send	Output			
CTSx	USARTx Clear To Send	Input			
DTR0	USART0 Data Terminal Ready	I/O			
DSR0	USART0 Data Set Ready	Input			
DCD0	USART0 Data Carrier Detect	Input			
RI0	USART0 Ring Indicator	Input			
	Synchronous Ser	ial Controller	- SSC		
TD	SSC Transmit Data	Output			
RD	SSC Receive Data	Input			
тк	SSC Transmit Clock	I/O			
RK	SSC Receive Clock	I/O			
TF	SSC Transmit Frame Sync	I/O			
RF	SSC Receive Frame Sync	I/O			
	Timer/Co	ounter - TC	1		
TCLKx	TC Channel x External Clock Input	Input			
TIOAx	TC Channel x I/O Line A	I/O			
TIOBx	TC Channel x I/O Line B	I/O			
	Pulse Width Modulat	ion Controlle	r- PWMC		
PWMHx	PWM Waveform Output High for channel x	Output			
PWMLx	PWM Waveform Output Low for channel x	Output			only output in complementary mode when dead time insertion is enabled
PWMFI0-2	PWM Fault Input	Input			
	Serial Peripher	al Interface - S	SPI	•	
MISO	Master In Slave Out	I/O			
MOSI	Master Out Slave In	I/O			
SPCK	SPI Serial Clock	I/O			
NPCS0	SPI Peripheral Chip Select 0	I/O	Low		
NPCS1 - NPCS3	SPI Peripheral Chip Select	Output	Low		





Table 3-1. Signal Description List (Continued)

Signal Name	Function	Туре	Active Level	Voltage Reference	Comments
Two-Wire Interface - TWI					
TWDx	TWIx Two-wire Serial Data	I/O			
TWCKx	TWIx Two-wire Serial Clock	I/O			
	12-bit Analog-to-Dig	tal Converter -	ADC12B		
AD12Bx	Analog Inputs	Analog			
AD12BTRG	ADC Trigger	Input			
AD12BVREF	ADC Reference	Analog			
	10-bit Analog-to-D	gital Converte	r - ADC		·
ADx	Analog Inputs	Analog			
ADTRG	ADC Trigger	Input			
ADVREF	ADC Reference	Analog			
	Fast Flash Program	nming Interface	e - FFPI		
PGMEN0-PGMEN2	Programming Enabling	Input			
PGMM0-PGMM3	Programming Mode	Input			
PGMD0-PGMD15	Programming Data	I/O			
PGMRDY	Programming Ready	Output	High	VDDIO	
PGMNVALID	Data Direction	Output	Low	VDDIO	
PGMNOE	Programming Read	Input	Low		
PGMCK	Programming Clock	Input			
PGMNCMD	Programming Command	Input	Low		
	USB High Spee	d Device - UDF	PHS	·	
DFSDM	USB Device Full Speed Data -	Analog			
DFSDP	USB Device Full Speed Data +	Analog			
DHSDM	USB Device High Speed Data -	Analog			
DHSDP	USB Device High Speed Data +	Analog			

Notes: 1. PIOA: Schmitt Trigger on all except PA14 on 100 and 144 packages.

2. PIOB: Schmitt Trigger on all except PB9 to PB16, PB25 to PB31 on 100 and 144 packages.

3. PIOC: Schmitt Trigger on all except PC20 to PC27 on 144 package.

3.1 Design Considerations

In order to facilitate schematic capture when using a SAM3U design, Atmel provides a "Schematics Checklist" Application note.

Please visit http://www.atmel.com/products/AT91/ for additional documentation.

4. Package and Pinout

The SAM3U4/2/1E is available in 144-lead LQFP and 144-ball LFBGA packages.

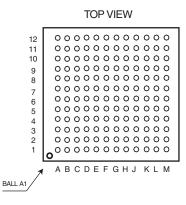
The SAM3U4/2/1C is available in 100-lead LQFP and 100-ball LFBGA packages.

4.1 SAM3U4/2/1E Package and Pinout

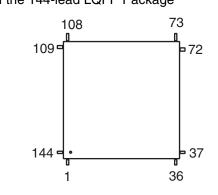
4.1.1 144-ball LFBGA Package Outline

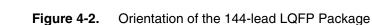
The 144-Ball LFBGA package has a 0.8 mm ball pitch and respects Green Standards. Its dimensions are 10 x 10 x 1.4 mm.

Figure 4-1. Orientation of the 144-ball LFBGA Package



4.1.2 144-lead LQFP Package Outline







4.1.3 144-lead LQFP Pinout

Table 4-1.144-pin SAM3U4/2/1E Pinout

1	TDI
2	VDDOUT
3	VDDIN
4	TDO/TRACESWO
5	PB31
6	PB30
7	TMS/SWDIO
8	PB29
9	TCK/SWCLK
10	PB28
11	NRST
12	PB27
13	PB26
14	PB25
15	PB24
16	VDDCORE
17	VDDIO
18	GND
19	PB23
20	PB22
21	PB21
22	PC21
23	PB20
24	PB19
25	PB18
26	PB17
27	VDDCORE
28	PC14
29	PB14
30	PB10
31	PB9
32	PC19
33	GNDPLL
34	VDDPLL
35	XOUT
36	XIN

2/1E	2/1E Pinout				
37	DHSDP				
38	DHSDM				
39	VBG				
40	VDDUTMI				
41	DFSDM				
42	DFSDP				
43	GNDUTMI				
44	VDDCORE				
45	PA28				
46	PA29				
47	PC22				
48	PA31				
49	PC23				
50	VDDCORE				
51	VDDIO				
52	GND				
53	PB0				
54	PC24				
55	PB1				
56	PC25				
57	PB2				
58	PC26				
59	PB11				
60	GND				
61	PB12				
62	PB13				
63	PC27				
64	PA27				
65	PB5				
66	PB6				
67	PB7				
68	PB8				
69	PC28				
70	PC29				
71	PC30				
72	PC31				

73	VDDANA
74	ADVREF
75	GNDANA
76	AD12BVREF
77	PA22/PGMD14
78	PA30
79	PB3
80	PB4
81	PC15
82	PC16
83	PC17
84	PC18
85	VDDIO
86	VDDCORE
87	PA13/PGMD5
88	PA14/PGMD6
89	PC10
90	GND
91	PA15/PGMD7
92	PC11
93	PA16/PGMD8
94	PC12
95	PA17/PGMD9
96	PB16
97	PB15
98	PC13
99	PA18/PGMD10
100	PA19/PGMD11
101	PA20/PGMD12
102	PA21/PGMD13
103	PA23/PGMD15
104	VDDIO
105	PA24
106	PA25
107	PA26
108	PC20

110 PC0 111 PA1/PGMR 112 PC1 113 PA2/PGMN 114 PC2 115 PA3/PGMNV/ 116 PC3 117 PA4/PGMN 118 PC4 119 PA5/PGMN	OE ALID 40
112 PC1 113 PA2/PGMN 114 PC2 115 PA3/PGMNV/ 116 PC3 117 PA4/PGMN 118 PC4 119 PA5/PGMN	OE ALID 40
113 PA2/PGMN 114 PC2 115 PA3/PGMNV/ 116 PC3 117 PA4/PGMN 118 PC4 119 PA5/PGMN	ALID 10
114 PC2 115 PA3/PGMNV/ 116 PC3 117 PA4/PGMN 118 PC4 119 PA5/PGMN	ALID 10
115 PA3/PGMNV/ 116 PC3 117 PA4/PGMN 118 PC4 119 PA5/PGMN	10
116 PC3 117 PA4/PGMM 118 PC4 119 PA5/PGMM	10
117 PA4/PGMN 118 PC4 119 PA5/PGMN	
118 PC4 119 PA5/PGMN	
119 PA5/PGMN	44
	14
120 PC5	/11
121 PA6/PGMN	/12
122 PC6	
123 PA7/PGMN	/13
124 PC7	
125 VDDCOR	E
126 GND	
127 VDDIO	
128 PA8/PGME	00
129 PC8	
130 PA9/PGME	01
131 PC9	
132 PA10/PGM	D2
133 PA11/PGM	D3
134 PA12/PGM	D4
135 FWUP	
136 SHDN	
137 ERASE	
138 TST	
139 VDDBU	
140 GNDBU	
141 NRSTB	
142 JTAGSEL	-
143 XOUT32	
144 XIN32	

SAM3U Series

4.1.4 144-ball LFBGA Pinout

Table 4-2. 144-ball SAM3U4/2/1E Pinout

A1	VBG
A2	VDDUTMI
A3	PB9
A4	PB10
A5	PB19
A6	PC21
A7	PB26
A8	TCK/SWCLK
A9	PB30
A10	TDO/TRACESWO
A11	XIN32
A12	XOUT32
B1	VDDCORE
B2	GNDUTMI
B3	XOUT
B4	PB14
B5	PB17
B6	PB22
B7	PB25
B8	PB29
B9	VDDIN
B10	JTAGSEL
B11	ERASE
B12	SHDN
C1	DFSDP
C2	DHSDP
C3	XIN
C4	VDDPLL
C5	PB18
C6	PB20
C7	PB27
C8	TMS/SWDIO
C9	VDDOUT
C10	NRSTB
C11	TST
C12	FWUP

2/1E Pinout				
D1	DFSDM			
D2	DHSDM			
D3	GNDPLL			
D4	PC14			
D5	PB21			
D6	PB23			
D7	PB24			
D8	PB28			
D9	TDI			
D10	VDDBU			
D11	PA10/PGMD2			
D12	PA11/PGMD3			
E1	PC22			
E2	PA28			
E3	PC19			
E4	VDDCORE			
E5	GND			
E6	VDDIO			
E7	GNDBU			
E8	NRST			
E9	PB31			
E10	PA12/PGMD4			
E11	PA8/PGMD0			
E12	PC8			
F1	PA31			
F2	PA29			
F3	PC23			
F4	VDDCORE			
F5	VDDIO			
F6	GND			
F7	GND			
F8	VDDIO			
F9	PC9			
F10	PA9/PGMD1			
F11	VDDCORE			
F12	PC7			

G1	PB0					
G2	PC26					
G3	PB2					
G4	PC25					
G5	PB1					
G6	GND					
G7	GND					
G8	VDDCORE					
G9 PC4						
G10 PA6/PGMM2						
G11 PA7/PGMM3						
G12	PC6					
H1	PC24					
H2	PC27					
H3	PA27					
H4 PB12						
H5 PB11						
H6 GND						
H7	VDDCORE					
H8	PB16					
H9	PB15					
H10 PC3						
H11	PA5/PGMM1					
H12	PC5					
J1	PB5					
J2	PB6					
JЗ	PC28					
J4	PB8					
J5	PB13					
J6 VDDIO						
J7	PA13/PGMD5					
J8	PA17/PGMD9					
J9	PC13					
J10	PA2/PGMNOE					
J11	PA3/PGMNVALID					
J12	PA4/PGMM0					

K1PB7K2PC31K3PC29K4PB3K5PB4K6PA14/PGMD6K7PA16/PGMD8K8PA18/PGMD10K9PC20K10PA1/PGMRDYK11PC1K12PC2L1PC30L2ADVREFL3AD12BVREFL4PA22/PGMD14L5PC17L6PC10L7PC12L8PA19/PGMD11L9PA23/PGMD15L10PA0/PGMNCMDL11PA26L12PC0M1VDDANAM2GNDANAM3PA30M4PC15M5PC16M6PC18M7PA15/PGMD7M8PC11M10PA20/PGMD12M11PA24M12PA25		
K3 PC29 K4 PB3 K5 PB4 K6 PA14/PGMD6 K7 PA16/PGMD8 K8 PA18/PGMD10 K9 PC20 K10 PA1/PGMRDY K11 PC1 K12 PC2 L1 PC30 L2 ADVREF L3 AD12BVREF L4 PA22/PGMD14 L5 PC10 L7 PC12 L8 PA19/PGMD11 L9 PA23/PGMD15 L10 PA00/PGMNCMD L11 PA26 L12 PC0 M1 VDDANA M2 GNDANA M3 PA30 M4 PC15 M5 PC16 M6 PC18 M7 PA15/PGMD12 M8 PC11 M9 PA20/PGMD12 M10 PA21/PGMD13	K1	PB7
K4 PB3 K5 PB4 K6 PA14/PGMD6 K7 PA16/PGMD8 K8 PA18/PGMD10 K9 PC20 K10 PA1/PGMRDY K11 PC1 K12 PC2 L1 PC30 L2 ADVREF L3 AD12BVREF L4 PA22/PGMD14 L5 PC17 L6 PC10 L7 PC12 L8 PA19/PGMD11 L9 PA23/PGMD15 L10 PA0/PGMNCMD L11 PA26 L12 PC0 M1 VDDANA M2 GNDANA M3 PA30 M4 PC15 M5 PC16 M6 PC18 M7 PA15/PGMD7 M8 PC11 M9 PA20/PGMD12 M10 PA21/PGMD13	K2	PC31
K5 PB4 K6 PA14/PGMD6 K7 PA16/PGMD8 K8 PA18/PGMD10 K9 PC20 K10 PA1/PGMRDY K11 PC1 K12 PC2 L1 PC30 L2 ADVREF L3 AD12BVREF L4 PA22/PGMD14 L5 PC17 L6 PC10 L7 PC12 L8 PA19/PGMD11 L9 PA23/PGMD15 L10 PA0/PGMNCMD L11 PA26 L12 PC0 M1 VDDANA M2 GNDANA M3 PA30 M4 PC15 M5 PC18 M7 PA15/PGMD7 M8 PC11 M9 PA20/PGMD12 M10 PA21/PGMD13	K3	PC29
K6 PA14/PGMD6 K7 PA16/PGMD8 K8 PA18/PGMD10 K9 PC20 K10 PA1/PGMRDY K11 PC1 K12 PC2 L1 PC30 L2 ADVREF L3 AD12BVREF L4 PA22/PGMD14 L5 PC17 L6 PC10 L7 PC12 L8 PA19/PGMD11 L9 PA23/PGMD15 L10 PA0/PGMNCMD L11 PA26 L12 PC0 M1 VDDANA M2 GNDANA M3 PA30 M4 PC15 M5 PC16 M6 PC18 M7 PA15/PGMD12 M8 PC11 M9 PA20/PGMD13 M10 PA21/PGMD13	K4	PB3
K7 PA16/PGMD8 K8 PA18/PGMD10 K9 PC20 K10 PA1/PGMRDY K11 PC1 K12 PC2 L1 PC30 L2 ADVREF L3 AD12BVREF L4 PA22/PGMD14 L5 PC17 L6 PC10 L7 PC12 L8 PA19/PGMD11 L9 PA23/PGMD15 L10 PA0/PGMNCMD L11 PA26 L12 PC0 M1 VDDANA M2 GNDANA M3 PA30 M4 PC15 M5 PC16 M6 PC18 M7 PA15/PGMD7 M8 PC11 M9 PA20/PGMD12 M10 PA21/PGMD13	K5	PB4
K8 PA18/PGMD10 K9 PC20 K10 PA1/PGMRDY K11 PC1 K12 PC2 L1 PC30 L2 ADVREF L3 AD12BVREF L4 PA22/PGMD14 L5 PC17 L6 PC10 L7 PC12 L8 PA19/PGMD11 L9 PA23/PGMD15 L10 PA0/PGMNCMD L11 PA26 L12 PC0 M1 VDDANA M2 GNDANA M3 PA30 M4 PC15 M5 PC16 M6 PC18 M7 PA15/PGMD7 M8 PC11 M9 PA20/PGMD12 M10 PA21/PGMD13	K6	PA14/PGMD6
K9 PC20 K10 PA1/PGMRDY K11 PC1 K12 PC2 L1 PC30 L2 ADVREF L3 AD12BVREF L4 PA22/PGMD14 L5 PC17 L6 PC10 L7 PC12 L8 PA19/PGMD11 L9 PA23/PGMD15 L10 PA0/PGMNCMD L11 PA26 L12 PC0 M1 VDDANA M2 GNDANA M3 PA30 M4 PC15 M5 PC16 M6 PC18 M7 PA15/PGMD12 M8 PC11 M9 PA20/PGMD12 M10 PA21/PGMD13	K7	PA16/PGMD8
K100 PA1/PGMRDY K11 PC1 K12 PC2 L1 PC30 L2 ADVREF L3 AD12BVREF L4 PA22/PGMD14 L5 PC17 L6 PC10 L7 PC12 L8 PA19/PGMD11 L9 PA23/PGMD15 L10 PA0/PGMNCMD L11 PA26 L12 PC0 M1 VDDANA M2 GNDANA M3 PA30 M4 PC15 M5 PC16 M6 PC18 M7 PA15/PGMD7 M8 PC11 M9 PA20/PGMD12 M10 PA21/PGMD13	K8	PA18/PGMD10
K111 PC1 K12 PC2 L1 PC30 L2 ADVREF L3 AD12BVREF L4 PA22/PGMD14 L5 PC17 L6 PC10 L7 PC12 L8 PA19/PGMD11 L9 PA23/PGMD15 L10 PA0/PGMNCMD L11 PA26 L12 PC0 M1 VDDANA M2 GNDANA M3 PA30 M4 PC15 M5 PC18 M7 PA15/PGMD7 M8 PC11 M9 PA20/PGMD12 M10 PA21/PGMD13	K9	PC20
K12 PC2 L1 PC30 L2 ADVREF L3 AD12BVREF L4 PA22/PGMD14 L5 PC17 L6 PC10 L7 PC12 L8 PA19/PGMD11 L9 PA23/PGMD15 L10 PA0/PGMNCMD L11 PA26 L12 PC0 M1 VDDANA M2 GNDANA M3 PA30 M4 PC15 M5 PC18 M7 PA15/PGMD7 M8 PC11 M9 PA20/PGMD12 M10 PA21/PGMD13	K10	PA1/PGMRDY
L1 PC30 L2 ADVREF L3 AD12BVREF L4 PA22/PGMD14 L5 PC17 L6 PC10 L7 PC12 L8 PA19/PGMD11 L9 PA23/PGMD15 L10 PA0/PGMNCMD L11 PA26 L12 PC0 M1 VDDANA M2 GNDANA M3 PA30 M4 PC15 M5 PC18 M7 PA15/PGMD7 M8 PC11 M9 PA20/PGMD12 M10 PA21/PGMD13	K11	PC1
L2 ADVREF L3 AD12BVREF L4 PA22/PGMD14 L5 PC17 L6 PC10 L7 PC12 L8 PA19/PGMD11 L9 PA23/PGMD15 L10 PA0/PGMNCMD L11 PA26 L12 PC0 M1 VDDANA M2 GNDANA M3 PA30 M4 PC15 M5 PC18 M7 PA15/PGMD7 M8 PC11 M9 PA20/PGMD12 M10 PA21/PGMD13 M11 PA24	K12	PC2
L3 AD12BVREF L4 PA22/PGMD14 L5 PC17 L6 PC10 L7 PC12 L8 PA19/PGMD11 L9 PA23/PGMD15 L10 PA0/PGMNCMD L11 PA26 L12 PC0 M1 VDDANA M2 GNDANA M3 PA30 M4 PC15 M5 PC16 M6 PC18 M7 PA15/PGMD7 M8 PC11 M9 PA20/PGMD12 M10 PA21/PGMD13 M11 PA24	L1	PC30
L4 PA22/PGMD14 L5 PC17 L6 PC10 L7 PC12 L8 PA19/PGMD11 L9 PA23/PGMD15 L10 PA0/PGMNCMD L11 PA26 L12 PC0 M1 VDDANA M2 GNDANA M3 PA30 M4 PC15 M5 PC16 M6 PC18 M7 PA15/PGMD7 M8 PC11 M9 PA20/PGMD13 M10 PA21/PGMD13 M11 PA24	L2	ADVREF
L5 PC17 L6 PC10 L7 PC12 L8 PA19/PGMD11 L9 PA23/PGMD15 L10 PA0/PGMNCMD L11 PA26 L12 PC0 M1 VDDANA M2 GNDANA M3 PA30 M4 PC15 M5 PC16 M6 PC18 M7 PA15/PGMD7 M8 PC11 M9 PA20/PGMD12 M10 PA21/PGMD13 M11 PA24	L3	AD12BVREF
L6 PC10 L7 PC12 L8 PA19/PGMD11 L9 PA23/PGMD15 L10 PA0/PGMNCMD L11 PA26 L12 PC0 M1 VDDANA M2 GNDANA M3 PA30 M4 PC15 M5 PC16 M6 PC18 M7 PA15/PGMD7 M8 PC11 M9 PA20/PGMD12 M10 PA21/PGMD13 M11 PA24	L4	PA22/PGMD14
L7 PC12 L8 PA19/PGMD11 L9 PA23/PGMD15 L10 PA0/PGMNCMD L11 PA26 L12 PC0 M1 VDDANA M2 GNDANA M3 PA30 M4 PC15 M5 PC16 M6 PC18 M7 PA15/PGMD7 M8 PC11 M9 PA20/PGMD12 M10 PA21/PGMD13 M11 PA24	L5	PC17
L8 PA19/PGMD11 L9 PA23/PGMD15 L10 PA0/PGMNCMD L11 PA26 L12 PC0 M1 VDDANA M2 GNDANA M3 PA30 M4 PC15 M5 PC16 M6 PC18 M7 PA15/PGMD7 M8 PC11 M9 PA20/PGMD12 M10 PA21/PGMD13 M11 PA24	L6	PC10
L9 PA23/PGMD15 L10 PA0/PGMNCMD L11 PA26 L12 PC0 M1 VDDANA M2 GNDANA M3 PA30 M4 PC15 M5 PC16 M6 PC18 M7 PA15/PGMD7 M8 PC11 M9 PA20/PGMD12 M10 PA21/PGMD13 M11 PA24	L7	PC12
L10 PA0/PGMNCMD L11 PA26 L12 PC0 M1 VDDANA M2 GNDANA M3 PA30 M4 PC15 M5 PC16 M6 PC18 M7 PA15/PGMD7 M8 PC11 M9 PA20/PGMD12 M10 PA21/PGMD13 M11 PA24	L8	PA19/PGMD11
L11 PA26 L12 PC0 M1 VDDANA M2 GNDANA M3 PA30 M4 PC15 M5 PC16 M6 PC18 M7 PA15/PGMD7 M8 PC11 M9 PA20/PGMD12 M10 PA21/PGMD13 M11 PA24	L9	PA23/PGMD15
L12 PC0 M1 VDDANA M2 GNDANA M3 PA30 M4 PC15 M5 PC16 M6 PC18 M7 PA15/PGMD7 M8 PC11 M9 PA20/PGMD12 M10 PA21/PGMD13 M11 PA24	L10	PA0/PGMNCMD
M1 VDDANA M2 GNDANA M3 PA30 M4 PC15 M5 PC16 M6 PC18 M7 PA15/PGMD7 M8 PC11 M9 PA20/PGMD12 M10 PA21/PGMD13 M11 PA24	L11	PA26
M2 GNDANA M3 PA30 M4 PC15 M5 PC16 M6 PC18 M7 PA15/PGMD7 M8 PC11 M9 PA20/PGMD12 M10 PA21/PGMD13 M11 PA24	L12	PC0
M3 PA30 M4 PC15 M5 PC16 M6 PC18 M7 PA15/PGMD7 M8 PC11 M9 PA20/PGMD12 M10 PA21/PGMD13 M11 PA24	M1	VDDANA
M4 PC15 M5 PC16 M6 PC18 M7 PA15/PGMD7 M8 PC11 M9 PA20/PGMD12 M10 PA21/PGMD13 M11 PA24	M2	GNDANA
M5 PC16 M6 PC18 M7 PA15/PGMD7 M8 PC11 M9 PA20/PGMD12 M10 PA21/PGMD13 M11 PA24	M3	PA30
M6 PC18 M7 PA15/PGMD7 M8 PC11 M9 PA20/PGMD12 M10 PA21/PGMD13 M11 PA24	M4	PC15
M7 PA15/PGMD7 M8 PC11 M9 PA20/PGMD12 M10 PA21/PGMD13 M11 PA24	M5	PC16
M8 PC11 M9 PA20/PGMD12 M10 PA21/PGMD13 M11 PA24	M6	PC18
M9 PA20/PGMD12 M10 PA21/PGMD13 M11 PA24	M7	PA15/PGMD7
M10 PA21/PGMD13 M11 PA24	M8	PC11
M11 PA24	M9	PA20/PGMD12
	M10	PA21/PGMD13
M12 PA25	M11	PA24
	M12	PA25



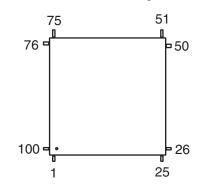
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4.2 SAM3U4/2/1C Package and Pinout

4.2.1 100-lead LQFP Package Outline

Figure 4-3. Orientation of the 100-lead LQFP Package



4.2.2 100-ball LFBGA Package Outline

Figure 4-4.	Orientation of the 100-ball LFBGA Package
-------------	---

	TOP VIEW										
		1	2	3	4	5	6	7	8	9	10
	•	0	0	0	0	0	_	0	0	0	0
A B		0	0	0	0	0	0	0	0	0	0
B C		0	0	0	0	0	0	0	0	0	0
D		0	0	0	0	0	0	0	0	0	0
E F		0	0	0	0	0	0	0	0	0	0
		0	0	0	0	0	0	0	0	0	0
G		0	0	0	0	0	-	0	0	0	0
Н		0	0	0	0	-	0	0	0	0	0
J		0	0	0	0	0	0	0	0	0	0
K		0	0	0	0	0	0	0	0	0	0

SAM3U Series

4.2.3 100-lead LQFP Pinout

Table 4-3.100-pin SAM3U4/2/1C1 Pinout

1	VDDANA	
2	ADVREF	
3	GNDANA	
4	AD12BVREF	
5	PA22/PGMD14	
6	PA30	
7	PB3	
8	PB4	
9	VDDCORE	
10	PA13/PGMD5	
11	PA14/PGMD6	
12	PA15/PGMD7	
13	PA16/PGMD8	
14	PA17/PGMD9	
15	PB16	
16	PB15	
17	PA18/PGMD10	
18	PA19/PGMD11	
19	PA20/PGMD12	
20	PA21/PGMD13	
21	PA23/PGMD15	
22	VDDIO	
23	PA24	
24	PA25	
25	PA26	

/2/10	i Pinoul
26	PA0/PGMNCMD
27	PA1/PGMRDY
28	PA2/PGMNOE
29	PA3/PGMNVALID
30	PA4/PGMM0
31	PA5/PGMM1
32	PA6/PGMM2
33	PA7/PGMM3
34	VDDCORE
35	GND
36	VDDIO
37	PA8/PGMD0
38	PA9/PGMD1
39	PA10/PGMD2
40	PA11/PGMD3
41	PA12/PGMD4
42	FWUP
43	ERASE
44	TST
45	VDDBU
46	GNDBU
47	NRSTB
48	JTAGSEL
49	XOUT32
50	XIN32

51	TDI						
52	VDDOUT						
53	VDDIN						
54	TDO/TRACESWO						
55	TMS/SWDIO						
56	TCK/SWCLK						
57	NRST						
58	PB24						
59	VDDCORE						
60	VDDIO						
61	GND						
62	PB23						
63	PB22						
64	PB21						
65	PB20						
66	PB19						
67	PB18						
68	PB17						
69	PB14						
70	PB10						
71	PB9						
72	GNDPLL						
73	VDDPLL						
74	XOUT						
75	XIN						

 76 DHSDP 77 DHSDM 78 VBG 79 VDDUTMI 80 DFSDM 81 DFSDP 82 GNDUTMI 	
78VBG79VDDUTMI80DFSDM81DFSDP	
79VDDUTMI80DFSDM81DFSDP	
80 DFSDM 81 DFSDP	
81 DFSDP	
82 GNDUTMI	
83 VDDCORE	
84 PA28	
85 PA29	
86 PA31	
87 VDDCORE	
88 VDDIO	
89 GND	
90 PB0	
91 PB1	
92 PB2	
93 PB11	
94 PB12	
95 PB13	
96 PA27	
97 PB5	
98 PB6	
99 PB7	
100 PB8	





4.2.4 **100-ball LFBGA Pinout**

				-			_		
A1	VBG	C6	PB22		F1	PB1		H6	PA15/PGMD7
A2	XIN	C7	TMS/SWDIO		F2	PB12	1	H7	PA18/PGMD10
A3	XOUT	C8	NRSTB		F3	VDDIO		H8	PA24
A4	PB17	C9	JTAGSEL		F4	PA31	1	H9	PA1/PGMRDY
A5	PB21	C10	VDDBU		F5	VDDIO]	H10	PA2/PGMNOE
A6	PB23	D1	DFSDM		F6	GND	1	J1	PB6
A7	TCK/SWCLK	D2	DHSDM		F7	PB16		J2	PB8
A8	VDDIN	D3	VDDPLL		F8	PA6/PGMM2	1	JЗ	ADVREF
A9	VDDOUT	D4	VDDCORE		F9	VDDCORE	1	J4	PA30
A10	XIN32	D5	PB20		F10	PA7/PGMM3		J5	PB3
B1	VDDCORE	D6	ERASE		G1	PB11		J6	PA16/PGMD8
B2	GNDUTMI	D7	TST		G2	PB2		J7	PA19/PGMD11
B3	VDDUTMI	D8	FWUP		G3	PB0		J8	PA21/PGMD13
B4	PB10	D9	PA11/PGMD3		G4	PB13	1	J9	PA26
B5	PB18	D10	PA12/PGMD4		G5	VDDCORE		J10	PA0/PGMNCMD
B6	PB24	E1	PA29		G6	GND		K1	PB7
B7	NRST	E2	GND		G7	PB15	1	K2	VDDANA
B8	TDO/TRACESWO	E3	PA28		G8	PA3/PGMNVALID	1	K3	GNDANA
B9	TDI	E4	PB9		G9	PA5/PGMM1	1	K4	AD12BVREF
B10	XOUT32	E5	GNDBU		G10	PA4/PGMM0]	K5	PB4
C1	DFSDP	E6	VDDIO		H1	VDDCORE]	K6	PA14/PGMD6
C2	DHSDP	E7	VDDCORE		H2	PB5	1	K7	PA17/PGMD9
C3	GNDPLL	E8	PA10/PGMD2		H3	PA27	1	K8	PA20/PGMD12
C4	PB14	E9	PA9/PGMD1		H4	PA22/PGMD14		K9	PA23/PGMD15
C5	PB19	E10	PA8/PGMD0		H5	PA13/PGMD5		K10	PA25
				-			_		

Table 4-4. 100-ball SAM3U4/2/1C Pinout

SAM3U Series 14

5. Power Considerations

5.1 Power Supplies

The SAM3U product has several types of power supply pins:

- VDDCORE pins: Power the core, the embedded memories and the peripherals; voltage ranges from 1.62V to 1.95V.
- VDDIO pins: Power the Peripherals I/O lines; voltage ranges from 1.62V to 3.6V.
- VDDIN pin: Powers the Voltage regulator
- VDDOUT pin: It is the output of the voltage regulator.
- VDDBU pin: Powers the Slow Clock oscillator and a part of the System Controller; voltage ranges from 1.62V to 3.6V. VDDBU must be supplied before or at the same time than VDDIO and VDDCORE.
- VDDPLL pin: Powers the PLL A, UPLL and 3-20 MHz Oscillator; voltage ranges from 1.62V to 1.95V.
- VDDUTMI pin: Powers the UTMI+ interface; voltage ranges from 3.0V to 3.6V, 3.3V nominal.
- VDDANA pin: Powers the ADC cells; voltage ranges from 2.0V to 3.6V.

Ground pins GND are common to VDDCORE and VDDIO pins power supplies.

Separated ground pins are provided for VDDBU, VDDPLL, VDDUTMI and VDDANA. These ground pins are respectively GNDBU, GNDPLL, GNDUTMI and GNDANA.

5.2 Voltage Regulator

The SAM3U embeds a voltage regulator that is managed by the Supply Controller.

This internal regulator is intended to supply the internal core of SAM3U but can be used to supply other parts in the application. It features two different operating modes:

- In Normal mode, the voltage regulator consumes less than 700 µA static current and draws 150 mA of output current. Internal adaptive biasing adjusts the regulator quiescent current depending on the required load current. In Wait Mode or when the output current is low, quiescent current is only 7µA.
- In Shutdown mode, the voltage regulator consumes less than 1 μ A while its output is driven internally to GND. The default output voltage is 1.80V and the start-up time to reach Normal mode is inferior to 400 μ s.

For adequate input and output power supply decoupling/bypassing, refer to "Voltage Regulator" in the "Electrical Characteristics" section of the product datasheet.

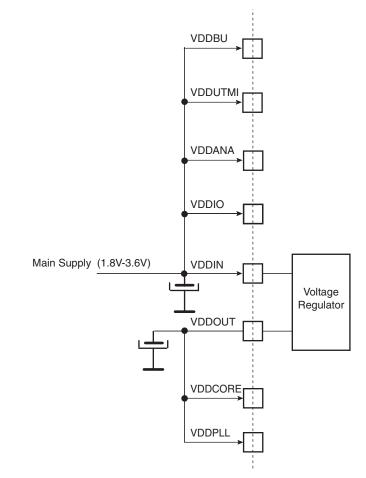
5.3 Typical Powering Schematics

The SAM3U supports a 1.8V-3.6V single supply mode. The internal regulator input connected to the source and its output feed VDDCORE. Figure 5-1, Figure 5-2, Figure 5-3 show the power schematics.

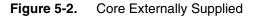


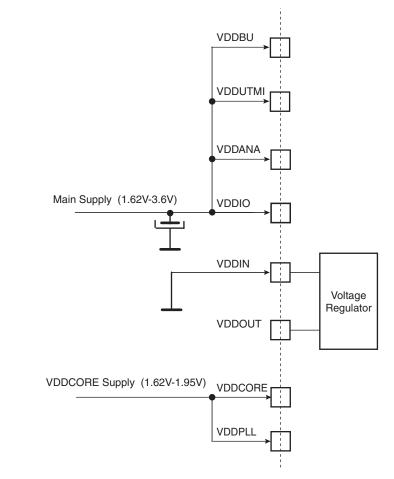


Figure 5-1. Single Supply



Note: Restrictions With Main Supply < 2.0 V, USB and ADC are not usable. With Main Supply \ge 2.4V and < 3V, USB is not usable. With Main Supply \ge 3V, all peripherals are usable.





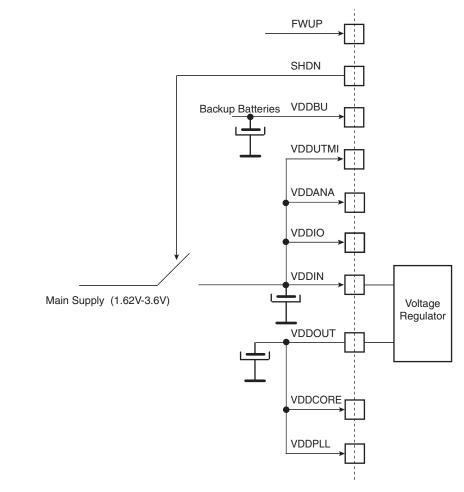
Note: Restrictions

With Main Supply < 2.0 V, USB and ADC are not usable. With Main Supply \ge 2.4V and < 3V, USB is not usable. With Main Supply \ge 3V, all peripherals are usable.





Figure 5-3. Backup Batteries Used



Note: Restrictions With Main Supply < 2.0 V, USB and ADC are not usable. With Main Supply \ge 2.4V and < 3V, USB is not usable. With Main Supply \ge 3V, all peripherals are usable.

5.4 Active Mode

Active mode is the normal running mode with the core clock running from the fast RC oscillator, the main crystal oscillator or the PLLA. The power management controller can be used to adapt the frequency and to disable the peripheral clocks.

5.5 Low Power Modes

The various low power modes of the SAM3U are described below:

5.5.1 Backup Mode

The purpose of backup mode is to achieve the lowest power consumption possible in a system which is performing periodic wake-ups to perform tasks but not requiring fast startup time (<0.5ms).

The Supply Controller, zero-power power-on reset, RTT, RTC, Backup registers and 32 kHz Oscillator (RC or crystal oscillator selected by software in the Supply Controller) are running. The regulator and the core supply are off.

Backup Mode is based on the Cortex-M3 deep-sleep mode with the voltage regulator disabled.

The SAM3U Series can be awakened from this mode through the Force Wake-Up pin (FWUP), and Wake-Up input pins WKUP0 to WKUP15, Supply Monitor, RTT or RTC wake-up event. Current Consumption is $2.5 \mu A$ typical on VDDBU.

Backup mode is entered by using WFE instructions with the SLEEPDEEP bit in the System Control Register of the Cortex-M3 set to 1. (See the "Power Management" description in The "ARM Cortex M3 Processor" section of the product datasheet).

Exit from Backup mode happens if one of the following enable wake up events occurs:

- FWUP pin (low level, configurable debouncing)
- WKUPEN0-15 pins (level transition, configurable debouncing)
- SM alarm
- RTC alarm
- RTT alarm

5.5.2 Wait Mode

The purpose of the wait mode is to achieve very low power consumption while maintaining the whole device in a powered state for a startup time of less than 10 μ s.

In this mode, the clocks of the core, peripherals and memories are stopped. However, the core, peripherals and memories power supplies are still powered. From this mode, a fast start up is available.

This mode is entered via Wait for Event (WFE) instructions with LPM = 1 (Low Power Mode bit in

PMC_FSMR). The Cortex-M3 is able to handle external events or internal events in order to wake-up the core (WFE). By configuring the external lines WKUP0-15 as fast startup wake-up pins (refer to Section 5.7 "Fast Start-Up"). RTC or RTT Alarm and USB wake-up events can be used to wake up the CPU (exit from WFE).

Current Consumption in Wait mode is typically 15 μ A on VDDIN if the internal voltage regulator is used or 8 μ A on VDDCORE if an external regulator is used.





Entering Wait Mode:

- Select the 4/8/12 MHz Fast RC Oscillator as Main Clock
- Set the LPM bit in the PMC Fast Startup Mode Register (PMC_FSMR)
- Execute the Wait-For-Event (WFE) instruction of the processor
- Note: Internal Main clock resynchronization cycles are necessary between the writing of MOSCRCEN bit and the effective entry in Wait mode. Depending on the user application, Waiting for MOSCRCEN bit to be cleared is recommended to ensure that the core will not execute undesired instructions.

5.5.3 Sleep Mode

The purpose of sleep mode is to optimize power consumption of the device versus response time. In this mode, only the core clock is stopped. The peripheral clocks can be enabled. This mode is entered via Wait for Interrupt (WFI) or Wait for Event (WFE) instructions with LPM = 0 in PMC_FSMR.

The processor can be awakened from an interrupt if WFI instruction of the Cortex M3 is used, or from an event if the WFE instruction is used to enter this mode.

5.5.4 Low Power Mode Summary Table

The modes detailed above are the main low power modes. Each part can be set to on or off separately and wake up sources can be individually configured. Table 5-1 below shows a summary of the configurations of the low power modes.

 Table 5-1.
 Low Power Mode Configuration Summary

Mode	SUPC, 32 kHz Oscillator RTC RTT Backup Registers, POR (VDDBU Region)	Regulator	Core Memory Peripherals	Mode Entry	Potential Wake Up Sources		PIO State while in Low Power Mode	PIO State at Wake Up	Consumption	Wake-up Time ⁽¹⁾
Backup Mode	ON	OFF SHDN =0	OFF (Not powered)	WFE +SLEEPDEEP bit = 1	FWUP pin WKUP0-15 pins BOD alarm RTC alarm RTT alarm	Reset	state saved	PIOA & PIOB & PIOC Inputs with pull ups	2.5 µА typ ⁽⁴⁾	< 0.5 ms
Wait Mode	ON	ON SHDN =1	Powered (Not clocked)	WFE +SLEEPDEEP bit = 0 +LPM bit = 1		Clocked back	Previous state saved	Unchanged	8 μΑ/15 μΑ ⁽⁵⁾	< 10 µs
Sleep Mode	ON	ON SHDN =1	Powered ⁽⁷⁾ (Not clocked)	WFE or WFI +SLEEPDEEP bit = 0 +LPM bit = 0	Entry mode =WFI Interrupt Only; Entry mode =WFE Any Enabled Interrupt and/or Any Event from: Fast start-up through WKUP0-15 pins RTC alarm RTT alarm USB wake-up	Clocked back	Previous state saved	Unchanged	(6)	(6)

Notes: 1. When considering wake-up time, the time required to start the PLL is not taken into account. Once started, the device works with the 4/8/12 MHz Fast RC oscillator. The user has to add the PLL start-up time if it is needed in the system. The wake-up time is defined as the time taken for wake up until the first instruction is fetched.

- 2. The external loads on PIOs are not taken into account in the calculation.
- 3. BOD current consumption is not included.
- 4. Current consumption on VDDBU.
- 8 μA total current consumption without using internal voltage regulator.
 15 μA total current consumption using internal voltage regulator.
- 6. Depends on MCK frequency.
- 7. In this mode the core is supplied and not clocked but some peripherals can be clocked.

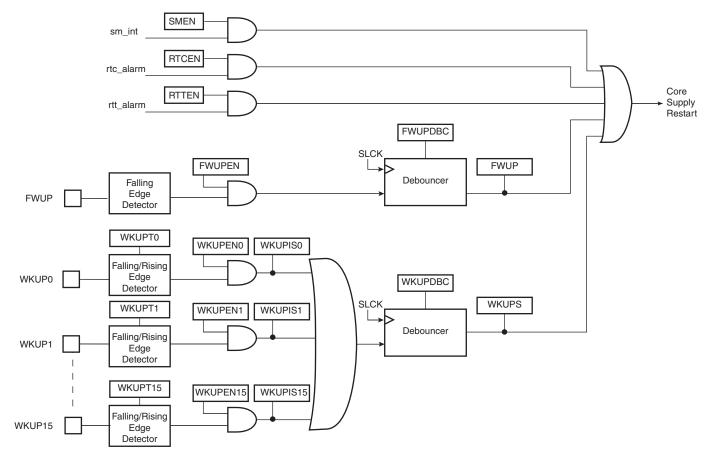




5.6 Wake-up Sources

The wake-up events allow the device to exit backup mode. When a wake-up event is detected, the Supply Controller performs a sequence which automatically reenables the core power supply.

Figure 5-4. Wake-up Source

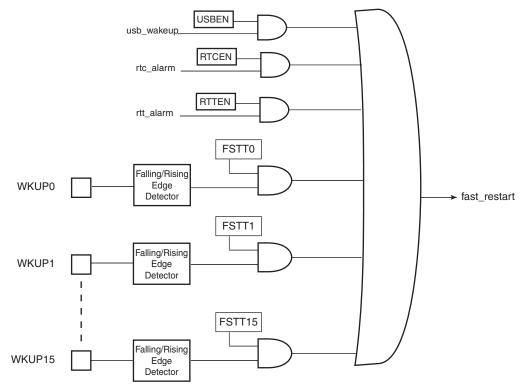


5.7 Fast Start-Up

The SAM3U allows the processor to restart in a few microseconds while the processor is in wait mode. A fast start up can occur upon detection of a low level on one of the 19 wake-up inputs.

The fast restart circuitry, as shown in Figure 5-5, is fully asynchronous and provides a fast startup signal to the Power Management Controller. As soon as the fast start-up signal is asserted, the PMC automatically restarts the embedded 4/8/12 MHz fast RC oscillator, switches the master clock on this 4/8/12 MHz clock and reenables the processor clock.

Figure 5-5. Fast Start-Up Sources







6. Input/Output Lines

The SAM3U has different kinds of input/output (I/O) lines, such as general purpose I/Os (GPIO) and system I/Os. GPIOs can have alternate functions thanks to multiplexing capabilities of the PIO controllers. The same GPIO line can be used whether it is in IO mode or used by the multiplexed peripheral. System I/Os are pins such as test pin, oscillators, erase pin, analog inputs or debug pins.

With a few exceptions, the I/Os have input schmitt triggers. Refer to the footnotes associated with "PIO Controller - PIOA - PIOB - PIOC" on page 6 within Table 3-1, "Signal Description List".

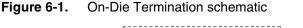
6.1 General Purpose I/O Lines (GPIO)

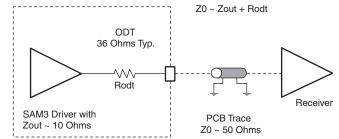
GPIO Lines are managed by PIO Controllers. All I/Os have several input or output modes such as, pull-up, input schmitt triggers, multi-drive (open-drain), glitch filters, debouncing or input change interrupt. Programming of these modes is performed independently for each I/O line through the PIO controller user interface. For more details, refer to the "PIO Controller" section of the product datasheet.

The input output buffers of the PIO lines are supplied through VDDIO power supply rail.

The SAM3U embeds high speed pads able to handle up to 65 MHz for HSMCI and SPI clock lines and 35 MHz on other lines. See "AC Characteristics" of the product datasheet for more details. Typical pull-up value is 100 k Ω for all I/Os.

Each I/O line also embeds an ODT (On-Die Termination), (see Figure 6-1 below). ODT consists of an internal series resistor termination scheme for impedance matching between the driver output (SAM3) and the PCB track impedance preventing signal reflection. The series resistor helps to reduce I/Os switching current (di/dt) thereby reducing in turn, EMI. It also decreases overshoot and undershoot (ringing) due to inductance of interconnect between devices or between boards. In conclusion, ODT helps reducing signal integrity issues.





6.2 System I/O Lines

System I/O lines are pins used by oscillators, test mode, reset, flash erase and JTAG to name but a few.

6.3 Serial Wire JTAG Debug Port (SWJ-DP)

The SWJ-DP pins are TCK/SWCLK, TMS/SWDIO, TDO/SWO, TDI and commonly provided on a standard 20-pin JTAG connector defined by ARM. For more details about voltage reference and reset state, refer to Table 3-1, "Signal Description List"

The JTAGSEL pin is used to select the JTAG boundary scan when asserted at a high level. It integrates a permanent pull-down resistor of about 15 k Ω to GNDBU, so that it can be left unconnected for normal operations.

By default, the JTAG Debug Port is active. If the debugger host wants to switch to the Serial Wire Debug Port, it must provide a dedicated JTAG sequence on TMS/SWDIO and TCK/SWCLK which disables the JTAG-DP and enables the SW-DP. When the Serial Wire Debug Port is active, TDO/TRACESWO can be used for trace.

The asynchronous TRACE output (TRACESWO) is multiplexed with TDO. So the asynchronous trace can only be used with SW-DP, not JTAG-DP.

All the JTAG signals are supplied with VDDIO except JTAGSEL, supplied by VDDBU.

6.4 Test Pin

The TST pin is used for JTAG Boundary Scan Manufacturing Test or fast flash programming mode of the SAM3U series. The TST pin integrates a permanent pull-down resistor of about 15 k Ω to GND, so that it can be left unconnected for normal operations. To enter fast programming mode, see the "Fast Flash Programming Interface" section of the product datasheet. For more on the manufacturing and test mode, refer to the "Debug and Test" section of the product datasheet.

6.5 NRST Pin

The NRST pin is bidirectional. It is handled by the on-chip reset controller and can be driven low to provide a reset signal to the external components or asserted low externally to reset the microcontroller. It will reset the Core and the peripherals, except the Backup region (RTC, RTT and Supply Controller). There is no constraint on the length of the reset pulse and the reset controller can guarantee a minimum pulse length.

The NRST pin integrates a permanent pull-up resistor to VDDIO of about 100 k Ω .

6.6 NRSTB Pin

The NRSTB pin is input only and enables asynchronous reset of the SAM3U when asserted low. The NRSTB pin integrates a permanent pull-up resistor of about 15 k Ω This allows connection of a simple push button on the NRSTB pin as a system-user reset. In all modes, this pin will reset the chip including the Backup region (RTC, RTT and Supply Controller). It reacts as the Power-on reset. It can be used as an external system reset source. In harsh environments, it is recommended to add an external capacitor (10 nF) between NRSTB and VDDBU. (For filtering values refer to "I/O Characteristics" in the "Electrical Characteristics" section of the product datasheet.)

It embeds an anti-glitch filter.

6.7 ERASE Pin

The ERASE pin is used to reinitialize the Flash content and some of its NVM bits. It integrates a permanent pull-down resistor of about 15 k Ω to GND, so that it can be left unconnected for normal operations.

This pin is debounced by SCLK to improve the glitch tolerance. When the ERASE pin is tied high during less than 100 ms, it is not taken into account. The pin must be tied high during more than 220 ms to perform the reinitialization of the Flash.





Even in all low power modes, asserting the pin will automatically start-up the chip and erase the Flash.

7. Processor and Architecture

7.1 ARM Cortex-M3 Processor

- Version 2.0
- Thumb-2 (ISA) subset consisting of all base Thumb-2 instructions, 16-bit and 32-bit.
- Harvard processor architecture enabling simultaneous instruction fetch with data load/store.
- Three-stage pipeline.
- Single cycle 32-bit multiply.
- Hardware divide.
- Thumb and Debug states.
- Handler and Thread modes.
- Low latency ISR entry and exit.

7.2 APB/AHB Bridges

The SAM3U product embeds two separated APB/AHB bridges:

- low speed bridge
- high speed bridge

This architecture enables to make concurrent accesses on both bridges.

All the peripherals are on the low-speed bridge except SPI, SSC and HSMCI.

The UART, 10-bit ADC (ADC), 12-bit ADC (ADC12B), TWI0-1, USART0-3, PWM have dedicated channels for the Peripheral DMA Channels (PDC). These peripherals can not use the DMA Controller.

The high speed bridge regroups the SSC, SPI and HSMCI. These three peripherals do not have PDC channels but can use the DMA with the internal FIFO for Channel buffering.

Note that the peripherals of the two bridges are clocked by the same source: MCK.

7.3 Matrix Masters

The Bus Matrix of the SAM3U device manages 5 masters, which means that each master can perform an access concurrently with others to an available slave.

Each master has its own decoder and specifically defined bus. In order to simplify the addressing, all the masters have the same decoding.

Master 0	Cortex-M3 Instruction/Data
Master 1	Cortex-M3 System
Master 2	Peripheral DMA Controller (PDC)
Master 3	USB Device High Speed DMA
Master 4	DMA Controller

Table 7-1. List of Bus Matrix Masters

7.4 Matrix Slaves

The Bus Matrix of the SAM3U manages 10 slaves. Each slave has its own arbiter, allowing a different arbitration per slave.

Table 7-2.	LIST OF DUS I	viatrix Slaves
Slave 0		Internal SRAM0
Slave 1		Internal SRAM1
Slave 2		Internal ROM
Slave 3		Internal Flash 0
Slave 4		Internal Flash 1
Slave 5		USB Device High Speed Dual Port RAM (DPR)
Slave 6		NAND Flash Controller RAM
Slave 7		External Bus Interface
Slave 8		Low Speed Peripheral Bridge
Slave 9		High Speed Peripheral Bridge

 Table 7-2.
 List of Bus Matrix Slaves

7.5 Master to Slave Access

All the Masters can normally access all the Slaves. However, some paths do not make sense, for example allowing access from the USB Device High speed DMA to the Internal Peripherals. Thus, these paths are forbidden or simply not wired, and shown as "–" in Table 7-3 below.

		0	1	2	3	4
Slaves	Masters	Cortex-M3 I/D Bus	Cortex-M3 S Bus	PDC	USB Device High Speed DMA	DMA Controller
0	Internal SRAM0	_	Х	Х	Х	Х
1	Internal SRAM1	_	Х	Х	Х	Х
2	Internal ROM	Х	_	Х	Х	Х
3	Internal Flash 0	Х	_	_	_	_
4	Internal Flash 1	Х	_	_	_	-
5	USB Device High Speed Dual Port RAM (DPR)	_	Х	_	_	_
6	NAND Flash Controller RAM	_	Х	Х	Х	Х
7	External Bus Interface	_	Х	Х	Х	Х
8	Low Speed Peripheral Bridge	_	Х	Х	_	_
9	High Speed Peripheral Bridge	_	Х	Х	-	_





7.6 DMA Controller

- Acting as one Matrix Master
- Embeds 4 channels:
 - 3 channels with 8 bytes/FIFO for Channel Buffering
 - 1 channel with 32 bytes/FIFO for Channel Buffering
- · Linked List support with Status Write Back operation at End of Transfer
- Word, HalfWord, Byte transfer support.
- Handles high speed transfer of SPI, SSC and HSMCI (peripheral to memory, memory to peripheral)
- · Memory to memory transfer
- Can be triggered by PWM and T/C which enables to generate waveforms though the External Bus Interface

The DMA controller can handle the transfer between peripherals and memory and so receives the triggers from the peripherals listed below. The hardware interface numbers are also given in Table 7-4 below.

Instance name	Channel T/R	DMA Channel HW interface Number
HSMCI	Transmit/Receive	0
SPI	Transmit	1
SPI	Receive	2
SSC	Transmit	3
SSC	Receive	4
PWM Event Line 0	Trigger	5
PWM Event Line 1	Trigger	6
TIO Output of TImer Counter Channel 0	Trigger	7

Table 7-4. DMA Controller

7.7 Peripheral DMA Controller

- Handles data transfer between peripherals and memories
- Nineteen channels
 - Two for each USART
 - Two for the UART
 - Two for each Two Wire Interface
 - One for the PWM
 - One for each Analog-to-digital Converter
- Low bus arbitration overhead
 - One Master Clock cycle needed for a transfer from memory to peripheral
 - Two Master Clock cycles needed for a transfer from peripheral to memory
- Next Pointer management for reducing interrupt latency requirement

The Peripheral DMA Controller handles transfer requests from the channel according to the following priorities (Low to High priorities):

Instance name	Channel T/R
TWI1	Transmit
TWIO	Transmit
PWM	Transmit
UART	Transmit
USART3	Transmit
USART2	Transmit
USART1	Transmit
USART0	Transmit
TWIO	Receive
TWI1	Receive
UART	Receive
USART3	Receive
USART2	Receive
USART1	Receive
USART0	Receive
ADC	Receive
ADC12B	Receive

 Table 7-5.
 Peripheral DMA Controller

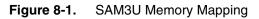
7.8 Debug and Test Features

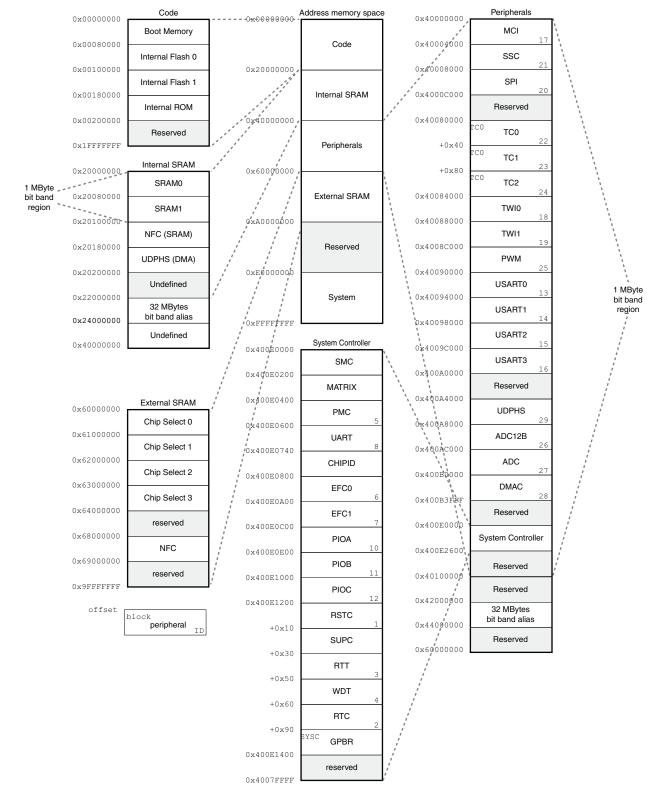
- Debug access to all memory and registers in the system, including Cortex-M3 register bank when the core is running, halted, or held in reset.
- Serial Wire Debug Port (SW-DP) and Serial Wire JTAG Debug Port (SWJ-DP) debug access
- Flash Patch and Breakpoint (FPB) unit for implementing break points and code patches
- Data Watchpoint and Trace (DWT) unit for implementing watch points, data tracing, and system profiling
- Instrumentation Trace Macrocell (ITM) for support of printf style debugging
- IEEE® 1149.1 JTAG Boundary-scan on all digital pins





8. Product Mapping





9. Memories

The embedded and external memories are described below.

9.1 Embedded Memories

9.1.1 Internal SRAM

The SAM3U4 (256 KBytes internal Flash version) embeds a total of 48 Kbytes high-speed SRAM (32 Kbytes SRAM0 and 16 Kbytes SRAM1).

The SAM3U2 (128 KBytes internal Flash version) embeds a total of 32 Kbytes high-speed SRAM (16 Kbytes SRAM0 and 16 Kbytes SRAM1).

The SAM3U1 (64 KBytes internal Flash version) embeds a total of 16 Kbytes high-speed SRAM (8 Kbytes SRAM0 and 8 Kbytes SRAM1).

The SRAM0 is accessible over System Cortex-M3 bus at address 0x2000 0000 and SRAM1 at address 0x2008 0000. The user can see the SRAM as contiguous.

The SRAM0 and SRAM1 are in the bit band region. The bit band alias region is from 0x2200 0000 and 0x23FF FFFF.

The NAND Flash Controller embeds 4224 bytes of internal SRAM. If the NAND Flash controller is not used, these 4224 Kbytes of SRAM can be used as general purpose. It can be seen at address 0x2010 0000.

9.1.2 Internal ROM

The SAM3U product embeds an Internal ROM, which contains the SAM-BA Boot and FFPI program.

At any time, the ROM is mapped at address 0x0018 0000.

9.1.3 Embedded Flash

9.1.3.1 Flash Overview

The Flash of the SAM3U4 (256 KBytes internal Flash version) is organized in two banks of 512 pages (dual plane) of 256 bytes.

The Flash of the SAM3U2 (128 KBytes internal Flash version) is organized in one bank of 512 pages (single plane) of 256 bytes.

The Flash of the is SAM3U1 (256 KBytes internal Flash version) organized in one bank of 256 pages (single plane) of 256 bytes.

The Flash contains a 128-byte write buffer, accessible through a 32-bit interface.

9.1.3.2 Flash Power Supply

The Flash is supplied by VDDCORE.

9.1.3.3 Enhanced Embedded Flash Controller

The Enhanced Embedded Flash Controller (EEFC) manages accesses performed by the masters of the system. It enables reading the Flash and writing the write buffer. It also contains a User Interface, mapped within the Memory Controller on the APB.

The Enhanced Embedded Flash Controller ensures the interface of the Flash block with the 32bit internal bus. Its 128-bit wide memory interface increases performance.





The user can choose between high performance or lower current consumption by selecting either 128-bit or 64-bit access. It also manages the programming, erasing, locking and unlocking sequences of the Flash using a full set of commands.

One of the commands returns the embedded Flash descriptor definition that informs the system about the Flash organization, thus making the software generic.

The SAM3U4 (256 KBytes internal Flash version) embeds two EEFC (EEFC0 for Flash0 and EEFC1 for Flash1) whereas the SAM3U2/1 embeds one EEFC.

9.1.3.4 Lock Regions

In the **SAM3U4** (256 KBytes internal Flash version) two Enhanced Embedded Flash Controllers each manage 16 lock bits to protect 32 regions of the flash against inadvertent flash erasing or programming commands.

The **SAM3U4** (256 KBytes internal Flash version) contains 32 lock regions and each lock region contains 32 pages of 256 bytes. Each lock region has a size of 8 Kbytes.

The **SAM3U2** (128 KBytes internal Flash version) Enhanced Embedded Flash Controller manages 16 lock bits to protect 32 regions of the flash against inadvertent flash erasing or programming commands.

The **SAM3U2** (128 KBytes internal Flash version) contains 16 lock regions and each lock region contains 32 pages of 256 bytes. Each lock region has a size of 8 Kbytes.

The **SAM3U1**(64 KBytes internal Flash version) Embedded Flash Controller manages 8 lock bits to protect 8 regions of the flash against inadvertent flash erasing or programming commands.

The **SAM3U1**(64 KBytes internal Flash version) contains 8 lock regions and each lock region contains 32 pages of 256 bytes. Each lock region has a size of 8 Kbytes.

If a locked-region's erase or program command occurs, the command is aborted and the EEFC triggers an interrupt.

The lock bits are software programmable through the EEFC User Interface. The command "Set Lock Bit" enables the protection. The command "Clear Lock Bit" unlocks the lock region.

Asserting the ERASE pin clears the lock bits, thus unlocking the entire Flash.

9.1.3.5 Security Bit Feature

The SAM3U features a security bit, based on a specific General Purpose NVM bit (GPNVM bit 0). When the security is enabled, any access to the Flash, SRAM, Core Registers and Internal Peripherals either through the ICE interface or through the Fast Flash Programming Interface, is forbidden. This ensures the confidentiality of the code programmed in the Flash.

This security bit can only be enabled, through the command "Set General Purpose NVM Bit 0" of

the EEFC User Interface. Disabling the security bit can only be achieved by asserting the ERASE pin at 1, and after a full Flash erase is performed. When the security bit is deactivated, all accesses to the Flash, SRAM, Core Registers and Internal Peripherals either through the ICE interface or through the Fast Flash Programming Interface are permitted.

It is important to note that the assertion of the ERASE pin should always be longer than 200 ms. As the ERASE pin integrates a permanent pull-down, it can be left unconnected during normal operation. However, it is safer to connect it directly to GND for the final application.

9.1.3.6 Calibration Bits

NVM bits are used to calibrate the brownout detector and the voltage regulator. These bits are factory configured and cannot be changed by the user. The ERASE pin has no effect on the calibration bits.

9.1.3.7 Unique Identifier

Each device integrates its own 128-bit unique identifier. These bits are factory configured and cannot be changed by the user. The ERASE pin has no effect on the unique identifier.

9.1.3.8 Fast Flash Programming Interface

The Fast Flash Programming Interface allows programming the device through either a serial JTAG interface or through a multiplexed fully-handshaked parallel port. It allows gang programming with market-standard industrial programmers.

The FFPI supports read, page program, page erase, full erase, lock, unlock and protect commands.

The Fast Flash Programming Interface is enabled and the Fast Programming Mode is entered when TST, NRSTB and FWUP pins are tied high during power up sequence and if all supplies are provided externally (do not use internal regulator for VDDCORE). Please note that since the FFPI is a part of the SAM-BA Boot Application, the device must boot from the ROM.

9.1.3.9 SAM-BA[®] Boot

The SAM-BA Boot is a default Boot Program which provides an easy way to program in-situ the on-chip Flash memory.

The SAM-BA Boot Assistant supports serial communication via the UART and USB.

The SAM-BA Boot provides an interface with SAM-BA Graphic User Interface (GUI).

The SAM-BA Boot is in ROM and is mapped in Flash at address 0x0 when GPNVM bit 1 is set to 0.

9.1.3.10 GPNVM Bits

The SAM3U features three GPNVM bits that can be cleared or set respectively through the commands "Clear GPNVM Bit" and "Set GPNVM Bit" of the EEFC User Interface.

The SAM3U4 is equipped with two EEFC, EEFC0 and EEFC1. EEFC1 does not feature the GPNVM bits. The GPNVM embedded on EEFC0 applies to the two blocks in the SAM3U4.

GPNVMBit[#]	Function
0	Security bit
1	Boot mode selection
2	Flash selection (Flash 0 or Flash 1) Only on SAM3U4 (256 Kbytes internal Flash version)

 Table 9-1.
 General-purpose Non-volatile Memory Bits

9.1.4 Boot Strategies

The system always boots at address 0x0. To ensure a maximum boot possibilities the memory layout can be changed via GPNVM.





A general purpose NVM (GPNVM1) bit is used to boot either on the ROM (default) or from the Flash.

The GPNVM bit can be cleared or set respectively through the commands "Clear General-purpose NVM Bit" and "Set General-purpose NVM Bit" of the EEFC User Interface.

Setting the GPNVM Bit 1 selects the boot from the Flash, clearing it selects the boot from the ROM. Asserting ERASE clears the GPNVM Bit 1 and thus selects the boot from the ROM by default.

GPNVM2 enables to select if Flash 0 or Flash 1 is used for the boot. Setting the GPNVM2 bit selects the boot from Flash 1, clearing it selects the boot from Flash 0.

9.2 External Memories

The SAM3U offers an interface to a wide range of external memories and to any parallel peripheral.

9.2.1 Static Memory Controller

- 8- or 16- bit Data Bus
- Up to 24-bit Address Bus (up to 16 MBytes linear per chip select)
- Up to 4 chips selects, Configurable Assignment
- Multiple Access Modes supported
 - Byte Write or Byte Select Lines
- Multiple device adaptability
 - Control signals programmable setup, pulse and hold time for each Memory Bank
- Multiple Wait State Management
 - Programmable Wait State Generation
 - External Wait Request
 - Programmable Data Float Time
- Slow Clock mode supported

9.2.2 NAND Flash Controller

- · Handles automatic Read/Write transfer through 4224 bytes SRAM buffer
- DMA support
- Supports SLC NAND Flash technology
- Programmable timing on a per chip select basis
- Programmable Flash Data width 8-bit or 16-bit

9.2.3 NAND Flash Error Corrected Code Controller

- Integrated in the NAND Flash Controller
- Single bit error correction and 2-bit Random detection.
- Automatic Hamming Code Calculation while writing
 - ECC value available in a register
- Automatic Hamming Code Calculation while reading
 - Error Report, including error flag, correctable error flag and word address being detected erroneous

Supports 8- or 16-bit NAND Flash devices with 512-, 1024-, 2048- or 4096-byte pages





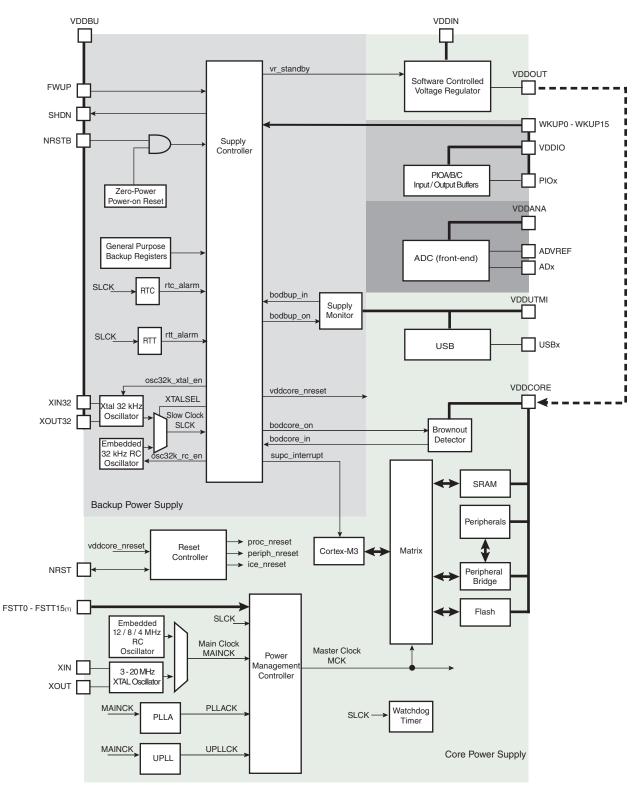
10. System Controller

The System Controller is a set of peripherals, which allow handling of key elements of the system, such as power, resets, clocks, time, interrupts, watchdog, etc...

The System Controller User Interface also embeds the registers used to configure the Matrix.

See the system controller block diagram in Figure 10-1 on page 37.





FSTT0 - FSTT15 are possible Fast Startup Sources, generated by WKUP0-WKUP15 Pins, but are not physical pins.





10.1 System Controller and Peripheral Mapping

Please refer to Figure 8-1"SAM3U Memory Mapping" on page 30.

All the peripherals are in the bit band region and are mapped in the bit band alias region.

10.2 Power-on-Reset, Brownout and Supply Monitor

The SAM3U embeds three features to monitor, warn and/or reset the chip:

- Power-on-Reset on VDDBU
- Brownout Detector on VDDCORE
- Supply Monitor on VDDUTMI

10.2.1 Power-on-Reset on VDDBU

The Power-on-Reset monitors VDDBU. It is always activated and monitors voltage at start up but also during power down. If VDDBU goes below the threshold voltage, the entire chip is reset. For more information, refer to the "Electrical Characteristics" section of the datasheet.

10.2.2 Brownout Detector on VDDCORE

The Brownout Detector monitors VDDCORE. It is active by default. It can be deactivated by software through the Supply Controller (SUPC_MR). It is especially recommended to disable it during low-power modes such as wait or sleep modes.

If VDDCORE goes below the threshold voltage, the reset of the core is asserted. For more information, refer to the "Supply Controller" and "Electrical Characteristics" sections of the product datasheet.

10.2.3 Supply Monitor on VDDUTMI

The Supply Monitor monitors VDDUTMI. It is not active by default. It can be activated by software and is fully programmable with 16 steps for the threshold (between 1.9V to 3.4V). It is controlled by the Supply Controller. A sample mode is possible. It allows to divide the supply monitor power consumption by a factor of up to 2048. For more information, refer to the "Supply Controller" and "Electrical Characteristics" sections of the product datasheet.

10.3 Reset Controller

The Reset Controller is capable to return to the software the source of the last reset, either a general reset, a wake-up reset, a software reset, a user reset or a watchdog reset.

The Reset Controller controls the internal resets of the system and the NRST pin output. It is capable to shape a reset signal for the external devices, simplifying to a minimum connection of a push-button on the NRST pin to implement a manual reset.

10.4 Supply Controller

The Supply Controller controls the power supplies of each section of the processor and the peripherals (via Voltage regulator control).

The Supply Controller has its own reset circuitry and is clocked by the 32 kHz Slow clock generator.

The reset circuitry is based on a zero-power power-on reset cell. The zero-power power-on reset allows the Supply Controller to start properly.

The Slow Clock generator is based on a 32 kHz crystal oscillator and an embedded 32 kHz RC oscillator. The Slow Clock defaults to the RC oscillator, but the software can enable the crystal oscillator and select it as the Slow Clock source.

The Supply Controller starts up the device by enabling the Voltage Regulator, then it generates the proper reset signals to the core power supply.

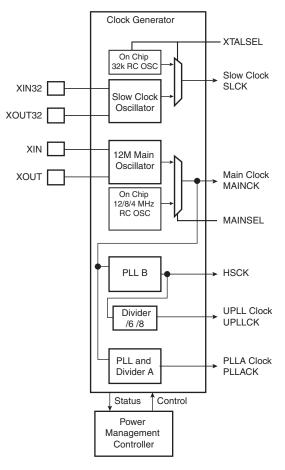
It also enables to set the system in different low power modes and to wake it up from a wide range of events.

10.5 Clock Generator

The Clock Generator is made up of:

- One Low Power 32768 Hz Slow Clock Oscillator with bypass mode
- One Low Power RC Oscillator
- One 3 to 20 MHz Crystal Oscillator, which can be bypassed
- One Fast RC Oscillator factory programmed, 3 output frequencies can be selected: 4, 8 or 12 MHz. By default 4 MHz is selected. 8 MHz and 12 MHz output are factory calibrated.
- One 480 MHz UPLL providing a clock for the USB High Speed Device Controller. Input frequency is 12 MHz (only).
- One 96 to 192 MHz programmable PLL (PLL A), capable to provide the clock MCK to the processor and to the peripherals. The input frequency of the PLL A is between 8 and 16 MHz.









10.6 Power Management Controller

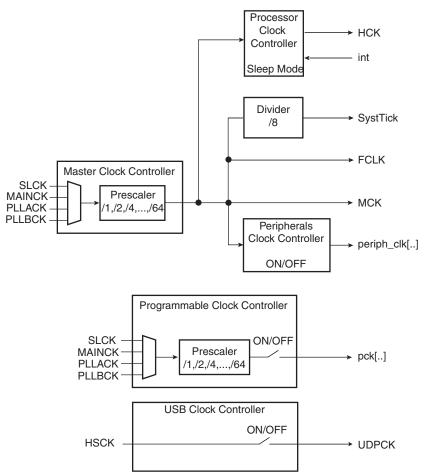
The Power Management Controller provides all the clock signals to the system. It provides:

- the Processor Clock HCLK
- the Free running processor clock FCLK
- the Cortex SysTick external clock
- the Master Clock MCK, in particular to the Matrix and the memory interfaces
- the USB Device HS Clock UDPCK
- independent peripheral clocks, typically at the frequency of MCK
- three programmable clock outputs: PCK0, PCK1 and PCK2

The Supply Controller selects between the 32 kHz RC oscillator or the crystal oscillator. The unused oscillator is disabled automatically so that power consumption is optimized.

By default, at startup the chip runs out of the Master Clock using the Fast RC Oscillator running at 4 MHz.





The SysTick calibration value is fixed at 10500, which allows the generation of a time base of 1 ms with SystTick clock to 10.5 MHz (max HCLK/8).

10.7 Watchdog Timer

- 16-bit key-protected once-only Programmable Counter
- Windowed, prevents the processor to be in a dead-lock on the watchdog access

10.8 SysTick Timer

- 24-bit down counter
- Self-reload capability
- Flexible system timer

10.9 Real-time Timer

- · Real-time Timer, allowing backup of time with different accuracies
 - 32-bit Free-running back-up Counter
 - Integrates a 16-bit programmable prescaler running on slow clock
 - Alarm Register capable to generate a wake-up of the system

10.10 Real-time Clock

- Low power consumption
- Full asynchronous design
- Two hundred year calendar
- Programmable Periodic Interrupt
- Alarm and update parallel load
- · Control of alarm and update Time/Calendar Data In

10.11 General-Purpose Back-up Registers

• Eight 32-bit general-purpose backup registers

10.12 Nested Vectored Interrupt Controller

- Thirty maskable interrupts
- · Sixteen priority levels
- Dynamic reprioritization of interrupts
- Priority grouping
 - selection of preempting interrupt levels and non preempting interrupt levels.
- Support for tail-chaining and late arrival of interrupts.
 - back-to-back interrupt processing without the overhead of state saving and restoration between interrupts.
- · Processor state automatically saved on interrupt entry, and restored on
 - interrupt exit, with no instruction overhead.





10.13 Chip Identification

• Chip Identifier (CHIPID) registers permit recognition of the device and its revision.

	Flash Size			
Chip Name	KByte	Pin Count	CHIPID_CIDR	CHIPID_EXID
SAM3U4C (Rev A)	256	100	0x28000960	0x0
SAM3U2C (Rev A)	128	100	0x280A0760	0x0
SAM3U1C (Rev A)	64	100	0x28090560	0x0
SAM3U4E (Rev A)	256	144	0x28100960	0x0
SAM3U2E (Rev A)	128	144	0x281A0760	0x0
SAM3U1E (Rev A)	64	144	0x28190560	0x0

 Table 10-1.
 SAM3U Chip IDs Register - Engineering Samples

• JTAG ID: 0x0582A03F

arts
arts

Chip Name	Flash Size KByte	Pin Count	CHIPID_CIDR	CHIPID_EXID
SAM3U4C (Rev A)	256	100	0x28000961	0x0
SAM3U2C (Rev A)	128	100	0x280A0761	0x0
SAM3U1C (Rev A)	64	100	0x28090561	0x0
SAM3U4E (Rev A)	256	144	0x28100961	0x0
SAM3U2E (Rev A)	128	144	0x281A0761	0x0
SAM3U1E (Rev A)	64	144	0x28190561	0x0

• JTAG ID: 0x0582A03F

10.14 PIO Controllers

- 3 PIO Controllers, PIOA, PIOB, and PIOC, controlling a maximum of 96 I/O Lines
- Each PIO Controller controls up to 32 programmable I/O Lines
 - PIOA has 32 I/O Lines
 - PIOB has 32 I/O Lines
 - PIOC has 32 I/O Lines
- Fully programmable through Set/Clear Registers
- Multiplexing of two peripheral functions per I/O Line
- For each I/O Line (whether assigned to a peripheral or used as general purpose I/O)
 - Input change, rising edge, falling edge, low level and level interrupt
 - Debouncing and Glitch filter
 - Multi-drive option enables driving in open drain
 - Programmable pull up on each I/O line
 - Pin data status register, supplies visibility of the level on the pin at any time
- Synchronous output, provides Set and Clear of several I/O lines in a single write





11. Peripherals

11.1 Peripheral Identifiers

Table 11-1 defines the Peripheral Identifiers of the SAM3U. A peripheral identifier is required for the control of the peripheral interrupt with the Nested Vectored Interrupt Controller and for the control of the peripheral clock with the Power Management Controller.

Note that some Peripherals are always clocked. Please refer to the table below.

Instance ID	Instance Name	NVIC Interrupt	PMC Clock Control	Instance Description	
0	SUPC	X		Supply Controller	
1	RSTC	X		Reset Controller	
2	RTC	x		Real Time Clock	
3	RTT	x		Real Time Timer	
4	WDT	x		Watchdog Timer	
5	РМС	X		Power Management Controller	
6	EEFC0	X		Enhanced Embedded Flash Controller 0	
7	EEFC1	X		Enhanced Embedded Flash Controller 1	
8	UART	X	X	Universal Asynchronous Receiver Transmitter	
9	SMC	X	X	Static Memory Controller	
10	PIOA	X	X	Parallel I/O Controller A,	
11	PIOB	X	X	Parallel I/O Controller B	
12	PIOC	X	X	Parallel I/O Controller C	
13	USART0	X	X	USART 0	
14	USART1	X	X	USART 1	
15	USART2	X	X	USART 2	
16	USART3	X	X	USART 3	
17	HSMCI	X	X	High Speed Multimedia Card Interface	
18	TWI0	Х	X	Two-Wire Interface 0	
19	TWI1	X	X	Two-Wire Interface 1	
20	SPI	X	X	Serial Peripheral Interface	
21	SSC	X	X	Synchronous Serial Controller	
22	TC0	x	X	Timer Counter 0	
23	TC1	x	X	Timer Counter 1	
24	TC2	X	X	Timer Counter 2	
25	PWM	X	X	Pulse Width Modulation Controller	
26	ADC12B	X	X	12-bit ADC Controller	
27	ADC	X	X	10-bit ADC Controller	
28	DMAC	X	X	DMA Controller	
29	UDPHS	Х	X	USB Device High Speed	

 Table 11-1.
 Peripheral Identifiers

11.2 Peripheral Signal Multiplexing on I/O Lines

The SAM3U features 3 PIO controllers, PIOA, PIOB and PIOC that multiplex the I/O lines of the peripheral set.

Each PIO Controller controls up to 32 lines. Each line can be assigned to one of two peripheral functions, A or B. The multiplexing tables in the following pages define how the I/O lines of peripherals A and B are multiplexed on the PIO Controllers. The two columns "Extra Function" and "Comments" have been inserted in this table for the user's own comments, they may be used to track how pins are defined in an application.

Note that some peripheral functions which are output only, might be duplicated within the tables.





11.2.1 PIO Controller A Multiplexing

I/O Line	Peripheral A	Peripheral B	Extra Function	Comments
PA0	TIOB0	NPCS1	WKUP0 ⁽¹⁾⁽²⁾	
PA1	TIOA0	NPCS2	WKUP1 ⁽¹⁾⁽²⁾	
PA2	TCLK0	AD12BTRG	WKUP2 ⁽¹⁾⁽²⁾	
PA3	MCCK	PCK1		
PA4	MCCDA	PWMH0		
PA5	MCDA0	PWMH1		
PA6	MCDA1	PWMH2		
PA7	MCDA2	PWML0		
PA8	MCDA3	PWML1		
PA9	TWD0	PWML2	WKUP3 ⁽¹⁾⁽²⁾	
PA10	TWCK0	PWML3	WKUP4 ⁽¹⁾⁽²⁾	
PA11	URXD	PWMFI0		
PA12	UTXD	PWMFI1		
PA13	MISO			
PA14	MOSI			
PA15	SPCK	PWMH2		
PA16	NPCS0	NCS1	WKUP5 ⁽¹⁾⁽²⁾	
PA17	SCK0	ADTRG	WKUP6 ⁽¹⁾⁽²⁾	
PA18	TXD0	PWMFI2	WKUP7 ⁽¹⁾⁽²⁾	
PA19	RXD0	NPCS3	WKUP8 ⁽¹⁾⁽²⁾	
PA20	TXD1	PWMH3	WKUP9 ⁽¹⁾⁽²⁾	
PA21	RXD1	РСК0	WKUP10 ⁽¹⁾⁽²⁾	
PA22	TXD2	RTS1	AD12B0	
PA23	RXD2	CTS1		
PA24	TWD1	SCK1	WKUP11 ⁽¹⁾⁽²⁾	Only on 144-pin version
PA25	TWCK1	SCK2	WKUP12 ⁽¹⁾⁽²⁾	Only on 144-pin version
PA26	TD	TCLK2		
PA27	RD	PCK0		
PA28	TK	PWMH0		
PA29	RK	PWMH1		
PA30	TF	TIOA2	AD12B1	
PA31	RF	TIOB2		

Table 11-2. Multiplexing on PIO Controller A (PIOA)

Notes: 1. Wake-Up source in Backup mode (managed by the SUPC).

2. Fast Start-Up source in Wait mode (managed by the PMC).

11.2.2 PIO Controller B Multiplexing

PB0 PWMH0 A2 WKUP13 ⁽¹⁾⁽²⁾ PB1 PWMH1 A3 WKUP14 ⁽¹⁾⁽²⁾ PB2 PWMH2 A4 WKUP15 ⁽¹⁾⁽²⁾ PB3 PWMH3 A5 AD12B2 PB4 TCLK1 A6 AD12B3 PB5 TIOA1 A7 AD0 PB6 TIOB1 D15 AD1 PB7 RTS0 A0/NBS0 AD2 PB8 CTS0 A1 AD3 PB9 D0 DTR0 PB10 PB10 D1 DSR0 PB11 PB12 D3 RI0 PB12 PB13 D4 PWMH0 PB14 PB15 D6 PWMH2 PB14 PB16 D7 PWMH3 PB17 PB18 NANDWE PWML0 PB14 PB19 NRD PWML2 PB2 PB20 NCS0 PWML3 PB2 PB21 A21/NANDALE RTS2 PB2 <th>Comments</th> <th>Extra Function</th> <th>Peripheral B</th> <th>Peripheral A</th> <th>I/O Line</th>	Comments	Extra Function	Peripheral B	Peripheral A	I/O Line
PB2 PWMH2 A4 WKUP15 ⁽¹⁾⁽²⁾ PB3 PWMH3 A5 AD12B2 PB4 TCLK1 A6 AD12B3 PB5 TIOA1 A7 AD0 PB6 TIOB1 D15 AD1 PB7 RTS0 A0/NBS0 AD2 PB8 CTS0 A1 AD3 PB9 D0 DTR0 PB10 D1 DSR0 PB11 D2 DCD0 PB13 D4 PWMH0 PB14 D5 PWMH1 PB15 D6 PWMH2 PB16 D7 PWML1 PB17 NANDOE PWML1 PB18 NANDWE PWML1 PB20 NCS0 PWML3 PB21 A21/NANDALE RTS2 <td></td> <td>WKUP13⁽¹⁾⁽²⁾</td> <td>A2</td> <td>PWMH0</td> <td>PB0</td>		WKUP13 ⁽¹⁾⁽²⁾	A2	PWMH0	PB0
PB3 PWMH3 A5 AD12B2 PB4 TCLK1 A6 AD12B3 I PB5 TIOA1 A7 AD0 I PB6 TIOB1 D15 AD1 I PB7 RTS0 A0/NBS0 AD2 I PB8 CTS0 A1 AD3 I PB9 D0 DTR0 I I PB10 D1 DSR0 I I PB11 D2 DCD0 I I PB12 D3 RI0 I I PB14 D5 PWMH0 I I PB15 D6 PWMH2 I I PB16 D7 PWMH3 I I PB17 NANDOE PWML0 I I PB18 NANDWE PWML1 I I PB20 NCS0 PWML3 I I PB21 A21/NANDALE RTS2 <		WKUP14 ⁽¹⁾⁽²⁾	A3	PWMH1	PB1
PB4 TCLK1 A6 AD12B3 PB5 TIOA1 A7 AD0 A PB6 TIOB1 D15 AD1 A PB7 RTS0 A0/NBS0 AD2 A PB8 CTS0 A1 AD3 A PB9 D0 DTR0 A A PB10 D1 DSR0 A A PB11 D2 DCD0 A A PB12 D3 RIO A A PB13 D4 PWMH0 A A PB14 D5 PWMH1 A A PB15 D6 PWMH2 A A PB16 D7 PWML3 A A PB18 NANDOE PWML1 A A PB19 NRD PWML2 A A PB20 NCS0 PWML3 A A PB21 A21/NANDALE RTS2 A <td></td> <td>WKUP15⁽¹⁾⁽²⁾</td> <td>A4</td> <td>PWMH2</td> <td>PB2</td>		WKUP15 ⁽¹⁾⁽²⁾	A4	PWMH2	PB2
PB5 TIOA1 A7 AD0 PB6 TIOB1 D15 AD1 PB7 RTS0 A0/NBS0 AD2 PB8 CTS0 A1 AD3 PB9 D0 DTR0 PB10 D1 DSR0 PB11 D2 DCD0 PB12 D3 RI0 PB13 D4 PWMH0 PB16 D7 PWMH2 PB16 D7 PWMH3 PB17 NANDOE PWML1 PB18 NANDWE PWML1 PB19 NRD PWML2 PB20 NCS0 PWML3 PB21 A21/NANDALE RTS2 PB23 NWR0/NWE PCK2 PB24 NANDRDY PCK1 PB25 D8 PWML0 PB26 D9 PWML0 <td></td> <td>AD12B2</td> <td>A5</td> <td>PWMH3</td> <td>PB3</td>		AD12B2	A5	PWMH3	PB3
PB6 TIOB1 D15 AD1 PB7 RTS0 A0/NBS0 AD2 PB8 CTS0 A1 AD3 PB9 D0 DTR0 PB10 D1 DSR0 PB11 D2 DCD0 PB12 D3 RI0 PB13 D4 PWMH0 PB15 D6 PWMH2 PB16 D7 PWMH3 PB17 NANDOE PWML0 PB18 NANDWE PWML1 PB19 NRD PWML2 PB20 NCS0 PWML3 PB21 A21/NANDALE RTS2 PB23 NWR0/NWE PCK2 PB24 NANDRDY PCK1 PB25 D8 PWML0 PB26 D9 PWML1 PB27 D10 PWML2		AD12B3	A6	TCLK1	PB4
PB7 RTS0 A0/NBS0 AD2 PB8 CTS0 A1 AD3 PB9 D0 DTR0 PB10 D1 DSR0 PB11 D2 DCD0 PB12 D3 RI0 PB13 D4 PWMH0 PB14 D5 PWMH1 PB15 D6 PWMH2 PB16 D7 PWML3 PB17 NANDOE PWML1 PB18 NANDWE PWML2 PB20 NCS0 PWML3 PB21 A21/NANDALE RTS2 PB23 NWR0/NWE PCK2 PB24 NANDRDY PCK1 PB25 D8 PWML0		AD0	A7	TIOA1	PB5
PB8 CTS0 A1 AD3 PB9 D0 DTR0 PB10 D1 DSR0 PB11 D2 DCD0 PB12 D3 RI0 PB13 D4 PWMH0 PB14 D5 PWMH1 PB15 D6 PWMH2 PB16 D7 PWMH3 PB17 NANDOE PWML0 PB18 NANDWE PWML1 PB19 NRD PWML2 PB20 NCS0 PWML3		AD1	D15	TIOB1	PB6
PB9 D0 DTR0 PB10 D1 DSR0 PB11 D2 DCD0 PB12 D3 RI0 PB13 D4 PWMH0 PB14 D5 PWMH1 PB15 D6 PWMH2 PB16 D7 PWMH3 PB17 NANDOE PWML0 PB18 NANDWE PWML1 PB20 NCS0 PWML3 PB21 A21/NANDALE RTS2 PB23 NWR0/NWE PCK2 PB24 NANDRDY PCK1 PB25 D8 PWML0 PB26 D9 PWML2		AD2	A0/NBS0	RTS0	PB7
PB10 D1 DSR0 Image: scalar		AD3	A1	CTS0	PB8
PB11 D2 DCD0 PB12 D3 RI0 PB13 D4 PWMH0 PB14 D5 PWMH1 PB15 D6 PWMH2 PB16 D7 PWMH3 PB17 NANDOE PWML0 PB18 NANDWE PWML1 PB19 NRD PWML2 PB20 NCS0 PWML3 PB21 A21/NANDALE RTS2 PB23 NWR0/NWE PCK2 PB24 NANDRDY PCK1 PB25 D8 PWML0 PB26 D9 PWML1			DTR0	D0	PB9
PB12 D3 RI0 PB13 D4 PWMH0 PB14 D5 PWMH1 PB15 D6 PWMH2 PB16 D7 PWMH3 PB17 NANDOE PWML0 PB18 NANDWE PWML1 PB19 NRD PWML2 PB20 NCS0 PWML3 PB21 A21/NANDALE RTS2 PB23 NWR0/NWE PCK2 PB24 NANDRDY PCK1 PB25 D8 PWML0 PB26 D9 PWML1			DSR0	D1	PB10
PB13 D4 PWMH0 Image: scalar scala			DCD0	D2	PB11
PB14 D5 PWMH1 PB15 D6 PWMH2 PB16 D7 PWMH3 PB17 NANDOE PWML0 PB18 NANDWE PWML1 PB19 NRD PWML2 PB20 NCS0 PWML3 PB21 A21/NANDALE RTS2 PB23 NWR0/NWE PCK2 PB24 NANDRDY PCK1 PB25 D8 PWML0 PB26 D9 PWML0			RIO	D3	PB12
PB15 D6 PWMH2 PB16 D7 PWMH3 PB17 NANDOE PWML0 PB18 NANDWE PWML1 PB19 NRD PWML2 PB20 NCS0 PWML3 PB21 A21/NANDALE RTS2 PB22 A22/NANDCLE CTS2 PB23 NWR0/NWE PCK2 PB24 NANDRDY PCK1 PB25 D8 PWML0 PB26 D9 PWML1			PWMH0	D4	PB13
PB16D7PWMH3PB17NANDOEPWML0PB18NANDWEPWML1PB19NRDPWML2PB20NCS0PWML3PB21A21/NANDALERTS2PB22A22/NANDCLECTS2PB23NWR0/NWEPCK2PB24NANDRDYPCK1PB25D8PWML0PB26D9PWML1PB27D10PWML2			PWMH1	D5	PB14
PB17NANDOEPWML0PB18NANDWEPWML1PB19NRDPWML2PB20NCS0PWML3PB21A21/NANDALERTS2PB22A22/NANDCLECTS2PB23NWR0/NWEPCK2PB24NANDRDYPCK1PB25D8PWML0PB26D9PWML1PB27D10PWML2			PWMH2	D6	PB15
PB18NANDWEPWML1PB19NRDPWML2PB20NCS0PWML3PB21A21/NANDALERTS2PB22A22/NANDCLECTS2PB23NWR0/NWEPCK2PB24NANDRDYPCK1PB25D8PWML0PB26D9PWML1PB27D10PWML2			PWMH3	D7	PB16
PB19NRDPWML2PB20NCS0PWML3PB21A21/NANDALERTS2PB22A22/NANDCLECTS2PB23NWR0/NWEPCK2PB24NANDRDYPCK1PB25D8PWML0PB26D9PWML1PB27D10PWML2			PWML0	NANDOE	PB17
PB20NCS0PWML3PB21A21/NANDALERTS2PB22A22/NANDCLECTS2PB23NWR0/NWEPCK2PB24NANDRDYPCK1PB25D8PWML0PB26D9PWML1PB27D10PWML2			PWML1	NANDWE	PB18
PB21A21/NANDALERTS2PB22A22/NANDCLECTS2PB23NWR0/NWEPCK2PB24NANDRDYPCK1PB25D8PWML0PB26D9PWML1PB27D10PWML2			PWML2	NRD	PB19
PB22A22/NANDCLECTS2PB23NWR0/NWEPCK2PB24NANDRDYPCK1PB25D8PWML0PB26D9PWML1PB27D10PWML2			PWML3	NCS0	PB20
PB23NWR0/NWEPCK2PB24NANDRDYPCK1PB25D8PWML0PB26D9PWML1PB27D10PWML2			RTS2	A21/NANDALE	PB21
PB24 NANDRDY PCK1 PB25 D8 PWML0 PB26 D9 PWML1 PB27 D10 PWML2			CTS2	A22/NANDCLE	PB22
PB25 D8 PWML0 PB26 D9 PWML1 PB27 D10 PWML2			PCK2	NWR0/NWE	PB23
PB26 D9 PWML1 PB27 D10 PWML2			PCK1	NANDRDY	PB24
PB27 D10 PWML2	Only on 144-pin version		PWML0	D8	PB25
	Only on 144-pin version		PWML1	D9	PB26
PB28 D11 PWMI 3	Only on 144-pin version		PWML2	D10	PB27
	Only on 144-pin version		PWML3	D11	PB28
PB29 D12	Only on 144-pin version			D12	PB29
PB30 D13	Only on 144-pin version			D13	PB30
PB31 D14	Only on 144-pin version			D14	PB31

 Table 11-3.
 Multiplexing on PIO Controller B (PIOB)

Notes: 1. Wake-Up source in Backup mode (managed by the SUPC).

2. Fast Start-Up source in Wait mode (managed by the PMC).





11.2.3 PIO Controller C Multiplexing

Table 11-4.	Multiplexing on PIO Controller C (PIOC)	

I/O Line	Peripheral A	Peripheral B	Extra function	Comments
PC0	A2			Only on 144-pin version
PC1	A3			Only on 144-pin version
PC2	A4			Only on 144-pin version
PC3	A5	NPCS1		Only on 144-pin version
PC4	A6	NPCS2		Only on 144-pin version
PC5	A7	NPCS3		Only on 144-pin version
PC6	A8	PWML0		Only on 144-pin version
PC7	A9	PWML1		Only on 144-pin version
PC8	A10	PWML2		Only on 144-pin version
PC9	A11	PWML3		Only on 144-pin version
PC10	A12	CTS3		Only on 144-pin version
PC11	A13	RTS3		Only on 144-pin version
PC12	NCS1	TXD3		Only on 144-pin version
PC13	A2	RXD3		Only on 144-pin version
PC14	A3	NPCS2		Only on 144-pin version
PC15	NWR1/NBS1		AD12B4	Only on 144-pin version
PC16	NCS2	PWML3	AD12B5	Only on 144-pin version
PC17	NCS3		AD12B6	Only on 144-pin version
PC18	NWAIT		AD12B7	Only on 144-pin version
PC19	SCK3	NPCS1		Only on 144-pin version
PC20	A14			Only on 144-pin version
PC21	A15			Only on 144-pin version
PC22	A16			Only on 144-pin version
PC23	A17			Only on 144-pin version
PC24	A18	PWMH0		Only on 144-pin version
PC25	A19	PWMH1		Only on 144-pin version
PC26	A20	PWMH2		Only on 144-pin version
PC27	A23	PWMH3		Only on 144-pin version
PC28		MCDA4	AD4	Only on 144-pin version
PC29	PWML0	MCDA5	AD5	Only on 144-pin version
PC30	PWML1	MCDA6	AD6	Only on 144-pin version
PC31	PWML2	MCDA7	AD7	Only on 144-pin version

Notes: 1. Wake-Up source in Backup mode (managed by the SUPC).

2. Fast Start-Up source in Wait mode (managed by the PMC).

12. Embedded Peripherals Overview

12.1 Serial Peripheral Interface (SPI)

- Supports communication with serial external devices
 - Four chip selects with external decoder support allow communication with up to 15 peripherals
 - Serial memories, such as DataFlash and 3-wire EEPROMs
 - Serial peripherals, such as ADCs, DACs, LCD Controllers, CAN Controllers and Sensors
 - External co-processors
- Master or slave serial peripheral bus interface
 - 8- to 16-bit programmable data length per chip select
 - Programmable phase and polarity per chip select
 - Programmable transfer delays between consecutive transfers and between clock and data per chip select
 - Programmable delay between consecutive transfers
 - Selectable mode fault detection
- Very fast transfers supported
 - Transfers with baud rates up to MCK
 - The chip select line may be left active to speed up transfers on the same device

12.2 Two Wire Interface (TWI)

- Master, Multi-Master and Slave Mode Operation
- Compatibility with Atmel two-wire interface, serial memory and I²C compatible devices
- One, two or three bytes for slave address
- Sequential read/write operations
- Bit Rate: Up to 400 kbit/s
- General Call Supported in Slave Mode
- Connecting to PDC channel capabilities optimizes data transfers in Master Mode only
 - One channel for the receiver, one channel for the transmitter
 - Next buffer support

12.3 Universal Asynchronous Receiver Transceiver (UART)

- Two-pin UART
 - Implemented features are 100% compatible with the standard Atmel USART
 - Independent receiver and transmitter with a common programmable Baud Rate Generator
 - Even, Odd, Mark or Space Parity Generation
 - Parity, Framing and Overrun Error Detection
 - Automatic Echo, Local Loopback and Remote Loopback Channel Modes
 - Support for two PDC channels with connection to receiver and transmitter





12.4 Universal Synchronous Asynchronous Receiver Transmitter (USART)

- Programmable Baud Rate Generator
- 5- to 9-bit full-duplex synchronous or asynchronous serial communications
 - 1, 1.5 or 2 stop bits in Asynchronous Mode or 1 or 2 stop bits in Synchronous Mode
 - Parity generation and error detection
 - Framing error detection, overrun error detection
 - MSB- or LSB-first
 - Optional break generation and detection
 - By 8 or by-16 over-sampling receiver frequency
 - Hardware handshaking RTS-CTS
 - Receiver time-out and transmitter timeguard
 - Optional Multi-drop Mode with address generation and detection
 - Optional Manchester Encoding
- RS485 with driver control signal
- ISO7816, T = 0 or T = 1 Protocols for interfacing with smart cards
 - NACK handling, error counter with repetition and iteration limit
- SPI Mode
 - Master or Slave
 - Serial Clock programmable Phase and Polarity
 - SPI Serial Clock (SCK) Frequency up to MCK/6
- IrDA modulation and demodulation
 - Communication at up to 115.2 Kbps
- Test Modes
 - Remote Loopback, Local Loopback, Automatic Echo

12.5 Serial Synchronous Controller (SSC)

- Provides serial synchronous communication links used in audio and telecom applications (with CODECs in Master or Slave Modes, I²S, TDM Buses, Magnetic Card Reader, ...)
- · Contains an independent receiver and transmitter and a common clock divider
- Offers a configurable frame sync and data length
- Receiver and transmitter can be programmed to start automatically or on detection of different event on the frame sync signal
- Receiver and transmitter include a data signal, a clock signal and a frame synchronization signal

12.6 Timer Counter (TC)

- Three 16-bit Timer Counter Channels
- Wide range of functions including:
 - Frequency Measurement
 - Event Counting
 - Interval Measurement

- Pulse Generation
- Delay Timing
- Pulse Width Modulation
- Up/Down Capabilities
- Quadrature Decoder Logic
- Each channel is user-configurable and contains:
 - Three external clock inputs
 - Five internal clock inputs
 - Two multi-purpose input/output signals
- Two global registers that act on all three TC Channels

12.7 Pulse Width Modulation Controller (PWM)

- 4 channels, one 16-bit counter per channel
- Common clock generator, providing Thirteen Different Clocks
 - A Modulo n counter providing eleven clocks
 - Two independent Linear Dividers working on modulo n counter outputs
 - High Frequency Asynchronous clocking mode
- Independent channel programming
 - Independent Enable Disable Commands
 - Independent Clock Selection
 - Independent Period and Duty Cycle, with Double Buffering
 - Programmable selection of the output waveform polarity
 - Programmable center or left aligned output waveform
 - Independent Output Override for each channel
 - Independent complementary Outputs with 12-bit dead time generator for each channel
 - Independent Enable Disable Commands
 - Independent Clock Selection
 - Independent Period and Duty Cycle, with Double Buffering
- Synchronous Channel mode
 - Synchronous Channels share the same counter
 - Mode to update the synchronous channels registers after a programmable number of periods
- Connection to one PDC channel
 - Offers Buffer transfer without Processor Intervention, to update duty cycle of synchronous channels
- Two independent event lines which can send up to 8 triggers on ADC within a period
- Four programmable Fault Inputs providing asynchronous protection of outputs





12.8 High Speed Multimedia Card Interface (HSMCI)

- Compatibility with MultiMedia Card Specification Version 4.3
- Compatibility with SD Memory Card Specification Version 2.0
- Compatibility with SDIO Specification Version V2.0.
- Compatibility with CE-ATA Specification 1.1
- Cards clock rate up to Master Clock divided by 2
- Boot Operation Mode support
- High Speed mode support
- Embedded power management to slow down clock rate when not used
- HSMCI has one slot supporting
 - One MultiMediaCard bus (up to 30 cards) or
 - One SD Memory Card
 - One SDIO Card
- · Support for stream, block and multi-block data read and write
- Supports Connection to DMA controller
 - Minimizes Processor intervention for large buffer transfers
- Built in FIFO (32 bytes) with large Memory Aperture Supporting Incremental access
- Support for CE-ATA Completion Signal Disable Command

12.9 USB High Speed Device Port (UDPHS)

- USB V2.0 high-speed compliant, 480 MBits per second
- Embedded USB V2.0 UTMI+ high-speed transceiver
- Embedded 4-Kbyte dual-port RAM for endpoints
- Embedded 6 channels DMA controller
- Suspend/Resume logic
- Up to 2 or 3 banks for isochronous and bulk endpoints
- · Seven endpoints, configurable by software
- Maximum configuration: seven endpoints:
 - Endpoint 0: 64 bytes, 1 bank mode
 - Endpoint 1 & 2: 512 bytes, 2 banks mode, HS isochronous capable
 - Endpoint 3 & 4:64 bytes, 3 banks mode
 - Endpoint 5 & 6: 1024 bytes, 3 banks mode, HS isochronous capable

12.10 Analog-to-Digital Converter (ADC)

Two ADCs are embedded in the product.

12.10.1 12-bit High Speed ADC

- 8-channel ADC
- 12-bit 1 Msamples/sec. Cyclic Pipeline ADC
- Integrated 8-to-1 multiplexer
- 12-bit resolution

- · Selectable single ended or differential input voltage
- Programmable gain for maximum full scale input range
- · External voltage reference for better accuracy on low voltage inputs
- Individual enable and disable of each channel
- Multiple trigger sources
 - Hardware or software trigger
 - External trigger pin
 - Timer Counter 0 to 2 outputs TIOA0 to TIOA2 trigger
 - PWM trigger
- Sleep Mode and conversion sequencer
 - Automatic wakeup on trigger and back to sleep mode after conversions of all enabled channels

12.10.2 10-bit Low Power ADC

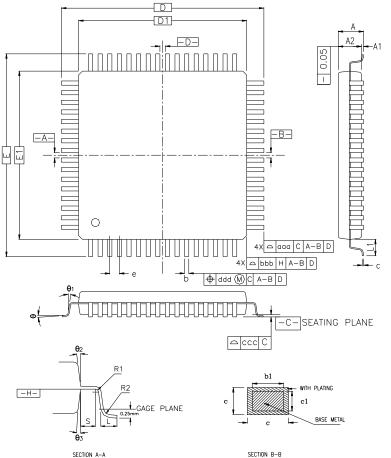
- 8-channel ADC
- 10-bit 384 Ksamples/sec. or 8-bit 533 Ksamples/sec. Successive Approximation Register ADC
- -2/+2 LSB Integral Non Linearity, -1/+1 LSB Differential Non Linearity
- Integrated 8-to-1 multiplexer
- External voltage reference for better accuracy on low voltage inputs
- Individual enable and disable of each channel
- Multiple trigger sources
 - Hardware or software trigger
 - External trigger pin
 - Timer Counter 0 to 2 outputs TIOA0 to TIOA2 trigger
 - PWM trigger
- Sleep Mode and conversion sequencer
 - Automatic wakeup on trigger and back to sleep mode after conversions of all enabled channels





13. Package Drawings

Figure 13-1. 100-ball LQFP Package Drawing



CONTROL	DIMEN	SIONS	ARE IN	MILLIN	I ETERS	
SYMBOL	MILLIMETER			INCH		
5111002	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
Α	—	—	1.60	—	—	0.063
A1	0.05		0.15	0.002	_	0.006
A2	1.35	1.40	1.45	0.053	0.055	0.057
D	10	5.00 B	SC.	0.	630 BS	SC.
D1	1.	4.00 B	SC.	0.	551 BS	SC.
E	16	5.00 B	SC.	0.	630 BS	SC.
E1	14	4.00 B	SC.	0.	551 BS	SC.
R2	0.08	—	0.20	0.003	—	0.008
R1	0.08	_	—	0.003	—	-
θ	0.	3.5*	7*	0.	3.5*	7'
θ1	0'	—	—	0.	—	—
θ2	11.	12*	13	11*	12	13*
θз	11*	12*	13'	11'	12'	13*
с	0.09		0.20	0.004	—	0.008
c1	0.09	0.127	0.16	0.004	0.005	0.006
L 1	1	.00 RE	F	0.	.039 R	EF
L	0.45	0.60	0.75	0.018	0.024	0.030
S	0.20	—		0.008		
b	0.17	—	0.27	0.007		0.011
b1	0.17			0.007		
е		0.50 E			20 BS0	
-	OLERANCES OF FORM AND POS					ЛС
000	0.20				.008	
bbb	0.20				0.008	
ccc		0.08				
ddd		0.08 0.003				

SECTION B-B

- NOTES :
- 1. DIMENSIONS D1 AND E1 DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.25mm PER SIDE. D1 AND E1 DO INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE $\mathbb H$
- 2. DIMENSION & DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08MM TOTAL IN EXESS OF THE b DIMENSION AT MAXIMUM MATERIAL CONDITION. DAMBAR CAN NOT BE LOCATED ON THE LOWER RADIUS OR THE FOOT

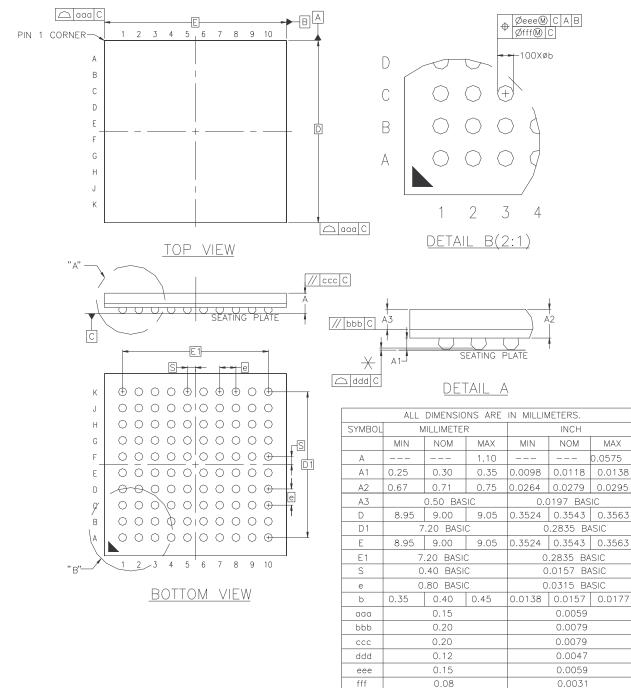
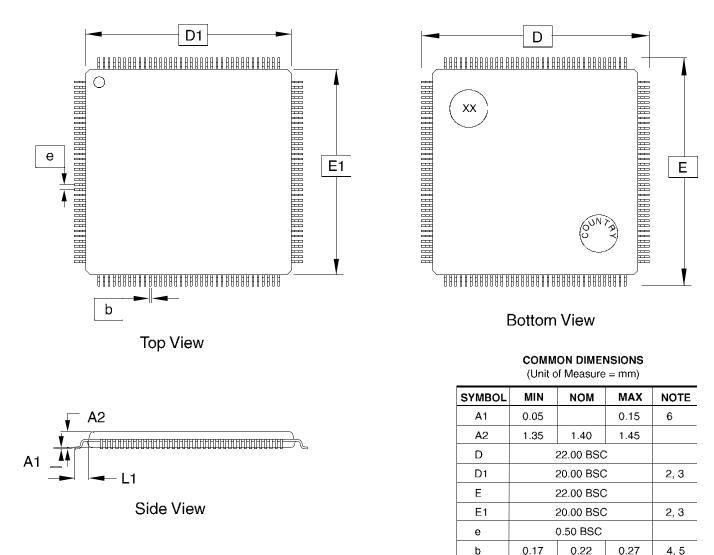


Figure 13-2. 100-ball LFBGA Package Drawing





Figure 13-3. 144-lead LQFP Package Drawing



Notes: 1. This drawing is for general information only; refer to JEDEe Drawing MS-026 for additional information.

- 2. The top package body size may be smaller than the bottom package size by as much as 0.15 mm.
- 3. Dimensions D1 and E1 do not include mold protrusions. Allowable protrusion is 0.25 mm per side. D1 and E1 are maximum plastic body size dimensions including mold mismatch.
- 4. b dimension by more than 0.08 mm. Dambar cannot be located on the lower radius or the foot. Minimum space between protrusion and an adjacent lead is 0.07 mm for 0.4 and 0.5 mm pitch packages.
- 5. These dimensions apply to the flat section of the lead between 0.10 mm and 0.25 mm from the lead tip.
- 6. A1 is defined as the distance from the seating place to the lowest point on the package body.

56 SAM3U Series

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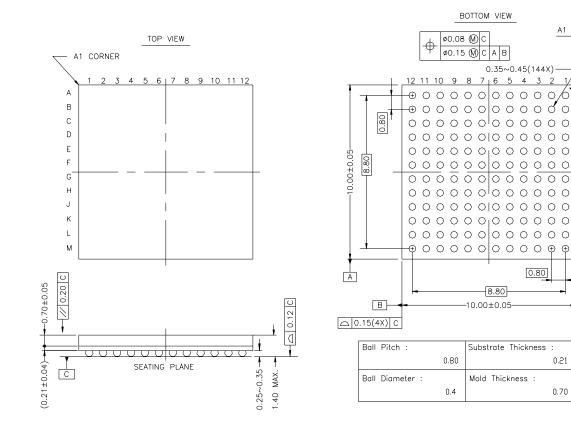
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All dimensions are in mm.





14. Ordering Information

Ordering Code	MRL	Flash (Kbytes)	Package	Package Type	Temperature Operating Range
ATSAM3U4EA-AU	А	256	LQFP144	Green	Industrial -40°C to 85°C
ATSAM3U4EA-CU	А	256	LFBGA 144	Green	Industrial -40°C to 85°C
ATSAM3U4CA-AU	А	256	LQFP 100	Green	Industrial -40°C to 85°C
ATSAM3U4CA-CU	А	256	TFBGA100	Green	Industrial -40°C to 85°C
ATSAM3U2EA-AU	А	128	LQFP144	Green	Industrial -40°C to 85°C
ATSAM3U2EA-CU	А	128	LFBGA144	Green	Industrial -40°C to 85°C
ATSAM3U2CA-AU	А	128	LQFP100	Green	Industrial -40°C to 85°C
ATSAM3U2CA-CU	А	128	TFBGA100	Green	Industrial -40°C to 85°C
ATSAM3U1EA-AU	А	64	LQFP144	Green	Industrial -40°C to 85°C
ATSAM3U1EA-CU	А	64	LFBGA144	Green	Industrial -40°C to 85°C
ATSAM3U1CA-AU	А	64	LQFP100	Green	Industrial -40°C to 85°C
ATSAM3U1CA-CU	А	64	TFBGA100	Green	Industrial -40°C to 85°C

Table 14-1. ATSAM3U4/2/1 Ordering Information

Revision History

In the tables that follow, the most recent version of the document appears first.

"rfo" indicates changes requested during the review and approval loop.

Doc. Rev 6430CS	Comments	Change Request Ref.
	Section 2. "SAM3U Block Diagram", changed orientation of block diagrams. Section 5. "Power Considerations", fixed grammar in Voltage ranges. Section 3. "Signal Description", USART signal DCD0 is an Input	rfo 6681
	Figure 5-1 "Single Supply", Main supply range is 1.8V-3.6V. Figure 5-1, Figure 5-2, Figure 5-3, updated "Note" below figures, "With Main Supply <2.0V USB and ADC are not usable.	6698
	Section 5.5 "Low Power Modes", stray references to WUPx pins, renamed WKUPx	6711
	Table 5-1, "Low Power Mode Configuration Summary", updated footnote "5".	6964
	Table 11-2, "Multiplexing on PIO Controller A (PIOA)", TWD1 and TWCK1 only available on 144-pin version.	6686
	Section 10.13 "Chip Identification" Table 10-2, "SAM3U Chip IDs Register - Revision A Parts", added to datasheet.	6951
	Section 12.4 "Universal Synchronous Asynchronous Receiver Transmitter (USART)""SCK up to MCK/6"	rfo ⊸ 7097





Doc Rev 6430BS	Comments	Change Request Ref.
	Introduction: Section 1. "SAM3U Description", Updated: 52 Kbytes of SRAM. 4x USARTs (SAM3U1C/2C/4C have 3), up to 2x TWIs (SAM3U1C/2C/4C have 1), up to 5x SPIs SAM3U1C/2C/4C have 4), Table 1-1, "Configuration Summary",EBI column updated, 8 bits for SAM3U1C/2C/4C SAM3U4/3/2C rows FWUP replaces NO in FWUP,SHDN pins column	6400
	Figure 2-1 "144-pin SAM3U4/2/1E Block Diagram" and Figure 2-2 "100-pin SAM3U4/2/1C Block Diagram" updated, SM cell removed; UART moved to peripheral area, added Flash Unique block, removed 12B from ADC block, added SysTick counter and Fmax 96 MHz to M3 block. FWUP replaces WKUP in fig 2-1, FWUP added to fig 2-2	6482/6642
	Figure 2-2 "100-pin SAM3U4/2/1C Block Diagram", NWR1/NBS1, NXRP0, A0 removed from block diagram.	rfo
	Table 3-1, "Signal Description List", Schmitt Trigger added "PIO Controller - PIOA - PIOB - PIOC". exception details given in footnote. VDDIN, VDDOUT added to table. "Serial Wire/JTAG Debug Port (SWJ-DP)" replaced ICE and JTAG. This section of the table updated status of pulldowns and pullups specified.	6480 rfo
	Section 4. "Package and Pinout", reorganized according to product. Section 4.1 "SAM3U4/2/1E Package and Pinout" and Section 4.2 "SAM3U4/2/1C Package and Pinout", pinouts finalized in datasheet.	6471/rfo 6607
	Section 5.5.1 "Backup Mode", BOD replaced by Supply Monitor/SM. FWUP →Falling Edge Detector. Figure 5-4 "Wake-up Source", BODEN replaced by SMEN. Table 5-1, "Low Power Mode Configuration Summary", PIO state in Low Power Modes, backup mode is; "Previous state saved.	rfo 6645
	Section 6.6 "NRSTB Pin", VDDIO changed to VDDBU Section 6. "Input/Output Lines", replaces Section 5.8 "Programmable I/O Lines". Section 6.1 "General Purpose I/O Lines (GPIO)" and Section 6.2 "System I/O Lines", replace Section 6. "I/O Line Considerations". Figure 6-1 "On-Die Termination schematic", added. Section 6.8 "PIO Controllers", removed. Section 8. "Product Mapping", title changed from "Memories". Section 9. "Memories", now comprises Section 9.1 "Embedded Memories" and Section 9.2 "External Memories". Section 9.1.3.5 "Security Bit Feature", updated	6646 6481/rfo
	Table 7-3, "SAM3U Master to Slave Access", Slave 9, High Speed Peripheral Bridge line added.Section 7.2 "APB/AHB Bridges", reference to ADC updated "10-bit ADC, 12-bit ADC (ADC12B)".Table 11-3, "Multiplexing on PIO Controller B (PIOB)", ADC12B2, ADC12B3 properly listed.Section 12.10.1 "12-bit High Speed ADC", Section 12.10.2 "10-bit Low Power ADC", titles changed."Quadrature Decoder Logic" on page 51, properly stated in list of TC functions.	6663 6397
	Section 12.10.1 "12-bit High Speed ADC", 2nd item on list updated. Section 12.10.2 "10-bit Low Power ADC", Ksample values updated on 2nd item of list.	rfo

Doc. Rev	Comments	Change Request Ref.
6430AS	First issue	





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